LTC4160/LTC4160-1

Switching Power Manager with USB On-The-Go And Overvoltage Protection

FEATURES

- **Bidirectional Switching Regulator Makes Optimal Use of Limited Power Available from USB Port and also Provides a 5V Output for USB On-The-Go**
- **Overvoltage Protection Guards Against Damage**
- **180mΩ Internal Ideal Diode Plus Optional External Ideal Diode Controller Seamlessly Provides Low Loss PowerPath When Input Power is Limited or Unavailable**
- **Instant-On Operation with Discharged Battery**
- Full Featured Li-Ion/Polymer Battery Charger
- Bat-Track™ Adaptive Output Control For Efficient Charging
- 1.2A Max Input Current Limit
- 1.2A Max Charge Current with Thermal Limiting
- Battery Float Voltage: 4.2V (LTC4160), 4.1V (LTC4160-1)
- Low Battery Powered Quiescent Current (8µA)
- Ultra-Thin (0.55mm) 20-pin 3mm × 4mm QFN Package

APPLICATIONS

- Media Players and Personal Navigation Devices
- Digital Cameras, PDAs, Smart Phones

DESCRIPTION

The LTC®4160/LTC4160-1 are high efficiency power management and Li-Ion/Polymer battery charger ICs. They each include a bidirectional switching PowerPath™ controller with automatic load prioritization, a battery charger, and an ideal diode.

The LTC4160/LTC4160-1's bidirectional switching regulator transfers nearly all of the power available from the USB port to the load with minimal loss and heat which eases thermal constraints in small spaces. These devices feature a precision input current limit for USB compatibility and Bat-Track output control for efficient charging. In addition, the ICs can also generate 5V at 500mA for USB On-The-Go applications.

An overvoltage circuit protects the LTC4160/LTC4160-1 from high voltage damage on the USB/wall adapter inputs with an external N-channel MOSFET and a resistor.

The LTC4160/LTC4160-1 are available in the ultra-thin (0.55 mm) 20-pin 3mm × 4mm UTQFN surface mount package.

⏀, LT, LTC and LTM are registered trademarks of Linear Technology Corporation. PowerPath and Bat-Track are a trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners. Protected by U.S. Patents including 6522118, 6404251. Other patents pending.

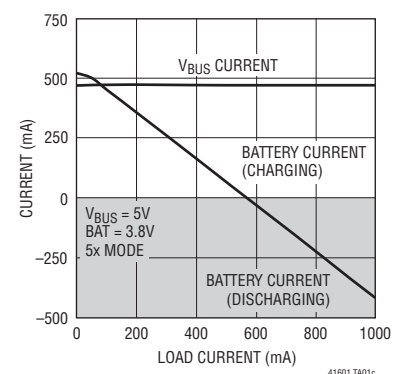## TYPICAL APPLICATION

USB OTG V_{BUS} Voltage vs V_{BUS} Current
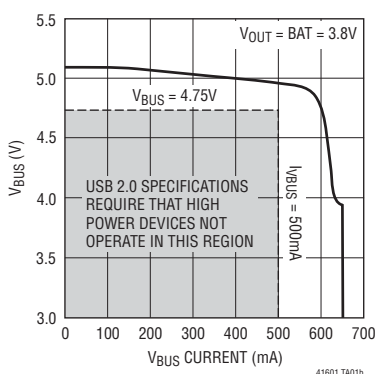
High Efficiency Power Manager/Battery Charger with USB On-The-Go and Overvoltage Protection

41601 TA01a
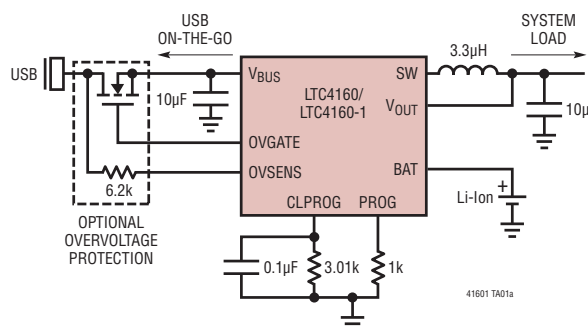
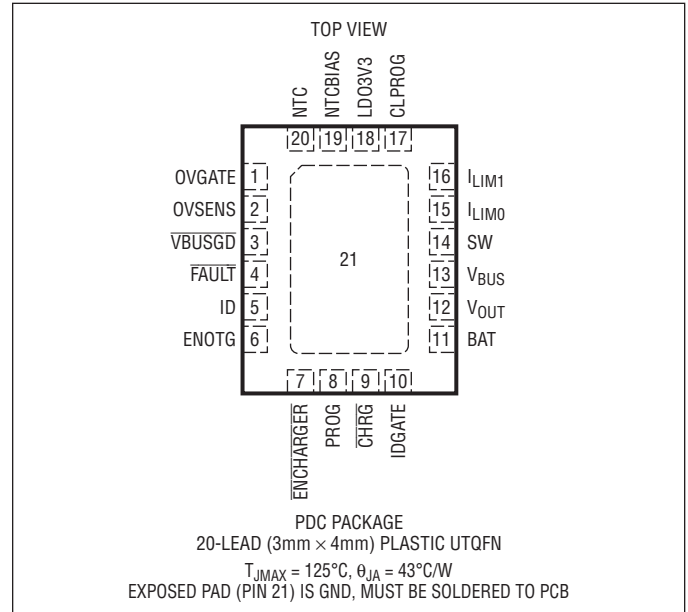### Battery and V_{BUS} Currents vs Load Current

41601f

LTC4160/LTC4160-1

ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2, 3)

V_{BUS} (Transient) t < 1ms, Duty Cycle < 1% .. −0.3V to 7V
V_{BUS} (Static), BAT, V_{OUT}, NTC, ENOTG, ID,
$\overline{ENCHARGER}$, $\overline{VBUSGD}$, $\overline{FAULT}$, $\overline{CHRG}$......... −0.3V to 6V
I_{LIM0}, I_{ILIM1} .... −0.3V to Max(V_{BUS}, V_{OUT}, BAT) + 0.3V
I_{OVSENS}..10mA
I_{CLPROG} 3mA
$I_{\overline{CHRG}}$, $I_{\overline{VBUSGD}}$, $I_{\overline{FAULT}}$..50mA
I_{PROG}..2mA
I_{LDO3V3}...30mA
I_{SW}, I_{BAT}, I_{VOUT}, I_{VBUS}..2A
Operating Temperature Range.................−40°C to 85°C
Maximum Junction Temperature.........................125°C
Storage Temperature Range..................−65°C to 125°C

PIN CONFIGURATION

TOP VIEW

```
         NTC  NTCBIAS  LDO3V3  CLPROG
         20    19      18      17

OVGATE   1                         16  I_LIM1
OVSENS   2                         15  I_LIM0
VBUSGD   3              21         14  SW
FAULT    4                         13  V_BUS
ID       5                         12  V_OUT
ENOTG    6                         11  BAT

         7     8      9      10

     ENCHARGER  PROG  CHRG  IDGATE
```

PDC PACKAGE
20-LEAD (3mm × 4mm) PLASTIC UTQFN
T_{JMAX} = 125°C, θ_{JA} = 43°C/W
EXPOSED PAD (PIN 21) IS GND, MUST BE SOLDERED TO PCB

ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC4160EPDC#PBF	LTC4160EPDC#TRPBF	FDRT	20-Lead (3mm × 4mm) Plastic UTQFN	−40°C to 85°C
LTC4160EPDC-1#PBF	LTC4160EPDC-1#TRPBF	FDST	20-Lead (3mm × 4mm) Plastic UTQFN	−40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.
Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/
For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{BUS} = 5V, BAT = 3.8V, R_{CLPROG} = 3.01k, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
PowerPath Switching Regulator – Step-Down Mode							
V_{BUS}	Input Supply Voltage			4.35		5.5	V
$I_{BUS(LIM)}$	Total Input Current	1x Mode	●	82	90	100	mA
		5x Mode	●	440	480	500	mA
		10x Mode	●	900	955	1000	mA
		Suspend Mode	●	0.32	0.43	0.5	mA
I_{VBUSQ} (Note 4)	Input Quiescent Current	1x Mode			7		mA
		5x, 10x Modes			20		mA
		Suspend Mode			0.050		mA
h_{CLPROG} (Note 4)	Ratio of Measured V_{BUS} Current to CL_{PROG} Program Current	1x Mode			211		mA/mA
		5x Mode			1170		mA/mA
		10x Mode			2377		mA/mA
		Suspend Mode			9.6		mA/mA

41601f

2

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{BUS} = 5V, BAT = 3.8V, R_{CLPROG} = 3.01k, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
$I_{VOUT(POWERPATH)}$	V_{OUT} Current Available Before Discharging Battery	1x Mode, BAT = 3.3V 5x Mode, BAT = 3.3V 10x Mode, BAT = 3.3V Suspend Mode		0.26	121 667 1217 0.34	0.43	mA mA mA mA
V_{CLPROG}	CLPROG Servo Voltage in Current Limit	Switching Modes Suspend Mode			1.183 100		V mV
V_{UVLO}	V_{BUS} Undervoltage Lockout	Rising Threshold Falling Threshold		3.95	4.3 4	4.35	V V
V_{DUVLO}	V_{BUS} To BAT Differential Undervoltage Lockout	Rising Threshold Falling Threshold			200 50		mV mV
V_{OUT}	V_{OUT} Voltage	1x, 5x, 10x Modes, 0V < BAT ≤ 4.2V, I_{VOUT} = 0mA, Battery Charger Off USB Suspend Mode, I_{VOUT} = 250µA		3.5 4.5	BAT + 0.3 4.6	4.7 4.7	V V
f_{OSC}	Switching Frequency			1.8	2.25	2.7	MHz
$R_{PMOS\_POWERPATH}$	PMOS On-Resistance				0.18		Ω
$R_{NMOS\_POWERPATH}$	NMOS On-Resistance				0.3		Ω
$I_{PEAK\_POWERPATH}$	Peak Inductor Current Clamp	1x Mode (Note 5) 5x Mode (Note 5) 10x Mode (Note 5)			1 1.6 3		A A A
R_{SUSP}	Suspend LDO Output Resistance	Closed Loop			10		Ω
PowerPath Switching Regulator – Step-Up Mode (USB On-The-Go)							
V_{BUS}	Output Voltage	0 ≤ I_{VBUS} ≤ 500mA, V_{OUT} > 3.2V		4.75		5.25	V
V_{OUT}	Input Voltage			2.9		4.2	V
I_{VBUS}	Output Current Limit		●	550	680		mA
I_{PEAK}	Peak Inductor Current Limit	(Note 5)			1.8		A
I_{OTGQ}	V_{OUT} Quiescent Current	V_{OUT} = 3.8V, I_{VBUS} = 0mA (Note 6)			1.6		mA
V_{CLPROG}	Output Current Limit Servo Voltage				1.15		V
$V_{OUTUVLO}$	V_{OUT} UVLO – V_{OUT} Falling V_{OUT} UVLO – V_{OUT} Rising			2.5	2.6 2.8	2.9	V V
$t_{SCFAULT}$	Short Circuit Fault Delay	PMOS Switch Off			7.2		ms
Overvoltage Protection							
$V_{OVCUTOFF}$	Overvoltage Protection Threshold	With 6.2k Series Resistor		6.1	6.42	6.7	V
V_{OVGATE}	OVGATE Output Voltage	V_{OVSENS} < $V_{OVCUTOFF}$ V_{OVSENS} > $V_{OVCUTOFF}$			1.88 • V_{OVSENS} 0	12	V V
t_{RISE}	OVGATE Time To Reach Regulation	OVGATE C_{LOAD} = 1nF			1.25		ms
Battery Charger							
V_{FLOAT}	BAT Regulated Output Voltage	LTC4160		4.179	4.2	4.221	V
			●	4.165	4.2	4.235	V
		LTC4160-1		4.079	4.1	4.121	V
			●	4.065	4.1	4.135	V
I_{CHG}	Constant Current Mode Charger Current	R_{PROG} = 845Ω, 10x Mode R_{CLPROG} ≤ 2.49k R_{PROG} = 5k, 5x or 10x Mode		1120 185	1219 206	1320 223	mA mA
I_{BAT}	Battery Drain Current	V_{BUS} > V_{UVLO}, Suspend Mode, I_{VOUT} = 0µA			3.8	6	µA
		V_{BUS} = 0V, I_{VOUT} = 0µA (Ideal Diode Mode)			8	12	µA

41601f

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{BUS} = 5V, BAT = 3.8V, R_{CLPROG} = 3.01k, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{PROG}	PROG Pin Servo Voltage			1		V
V_{PROG_TRKL}	PROG Pin Servo Voltage in Trickle Charge	BAT < V_{TRKL}		0.1		V
$V_{C/10}$	C/10 Threshold Voltage at PROG			100		mV
h_{PROG}	Ratio of I_{BAT} to PROG Pin Current			1030		mA/mA
I_{TRKL}	Trickle Charge Current	BAT < V_{TRKL}		100		mA
V_{TRKL}	Trickle Charge Threshold Voltage	BAT Rising	2.7	2.85	3	V
ΔV_{TRKL}	Trickle Charge Hysteresis Voltage			135		mV
ΔV_{RECHRG}	Recharge Battery Threshold Voltage	Threshold Voltage Relative to V_{FLOAT}	−75	−100	−125	mV
t_{TERM}	Safety Timer Termination Period	Timer Starts when V_{BAT} = V_{FLOAT}	3.9	4.3	5.4	Hour
t_{BADBAT}	Bad Battery Termination Time	BAT < V_{TRKL}	0.4	0.5	0.6	Hour
$h_{C/10}$	End of Charge Current Ratio	(Note 7)	0.085	0.1	0.115	mA/mA
R_{ON_CHG}	Battery Charger Power FET On-Resistance (Between V_{OUT} and BAT)			0.18		Ω
T_{LIM}	Junction Temperature in Constant Temperature Mode			110		°C

NTC

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{COLD}	Cold Temperature Fault Threshold Voltage	Rising Threshold Hysteresis	75	76.5 1.5	78	%NTCBIAS %NTCBIAS
V_{HOT}	Hot Temperature Fault Threshold Voltage	Falling Threshold Hysteresis	33.4	34.9 1.8	36.4	%NTCBIAS %NTCBIAS
V_{DIS}	NTC Disable Threshold Voltage	Falling Threshold Hysteresis	0.7	1.7 50	2.7	%NTCBIAS mV
I_{NTC}	NTC Leakage Current	NTC = NTCBIAS = 5V	−50		50	nA

Ideal Diode

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{FWD}	Forward Voltage Detection	V_{BUS} = 0V, I_{VOUT} = 10mA I_{VOUT} = 10mA		2 15		mV mV
$R_{DROPOUT}$	Internal Diode On-Resistance, Dropout	I_{VOUT} = 200mA		0.18		Ω
I_{MAX_DIODE}	Diode Current Limit		2			A

Always On 3.3V LDO Supply

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{LDO3V3}	Regulated Output Voltage	0mA < I_{LDO3V3} < 20mA	3.1	3.3	3.5	V
R_{CL_LDO3V3}	Closed-Loop Output Resistance			2.7		Ω
R_{OL_LDO3V3}	Dropout Output Resistance			23		Ω

Logic (I_{LIM0}, I_{LIM1}, ID, ENOTG, $\overline{ENCHARGER}$)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{IL}	Logic Low Input Voltage				0.4	V
V_{IH}	Logic High Input Voltage		1.2			V
I_{PD1}	I_{LIM0}, I_{LIM1}, ENOTG, $\overline{ENCHARGER}$ Pull-Down Current			1.8		µA
I_{PU1}	ID Pull-Up Current			2.5		µA

Status Outputs ($\overline{CHRG}$, $\overline{VBUSGD}$, $\overline{FAULT}$)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$V_{\overline{VBUSGD}}$	Output Low Voltage	$I_{\overline{VBUSGD}}$ = 5mA, V_{BUS} = 5V		65	100	mV
$V_{\overline{CHRG}}$, $V_{\overline{FAULT}}$	Output Low Voltage	$I_{\overline{CHRG}}$ = $I_{\overline{FAULT}}$ = 5mA, V_{OUT} = 3.8V		100	150	mV
$I_{\overline{CHRG}}$, $I_{\overline{VBUSGD}}$, $I_{\overline{FAULT}}$	Leakage Current	$V_{\overline{CHRG}}$ = $V_{\overline{VBUSGD}}$ = $V_{\overline{FAULT}}$ = 5V			1	µA

41601f

4

ELECTRICAL CHARACTERISTICS

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LTC4160E/LTC4160E-1 are guaranteed to meet performance specifications from 0°C to 85°C. Specifications over the –40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: The LTC4160E/LTC4160E-1 include overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed 125°C when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

Note 4: Total input current is the sum of quiescent current, I_{VBUSQ}, and measured current given by $V_{CLPROG}/R_{CLPROG} \cdot (h_{CLPROG} + 1)$.

Note 5: The current limit features of this part are intended to protect the IC from short term or intermittent fault conditions. Continuous operation above the maximum specified pin current rating may result in device degradation or failure.

Note 6: The bidirectional switcher's supply current is bootstrapped to V_{BUS} and in the application will reflect back to V_{OUT} by $(V_{BUS}/V_{OUT}) \cdot$ 1/efficiency. Total quiescent current is the sum of the current into the V_{OUT} pin plus the reflected current.
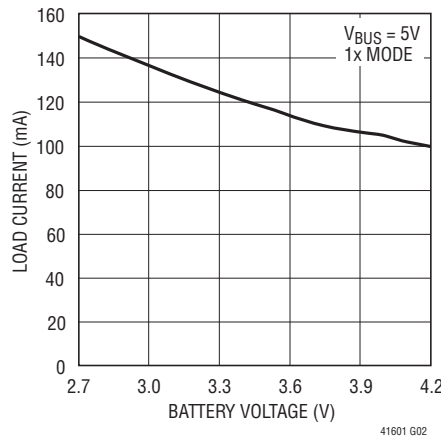
Note 7: $h_{C/10}$ is expressed as a fraction of the measured full charge current with indicated PROG resistor.

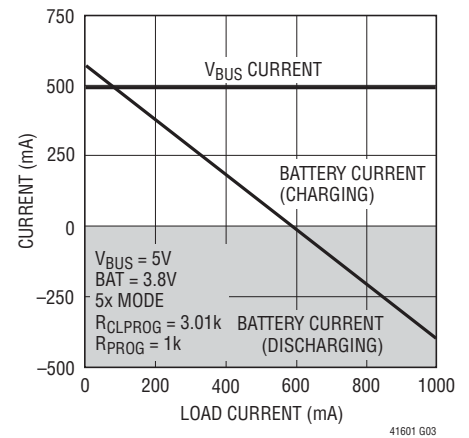# TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25°C$, unless otherwise noted.

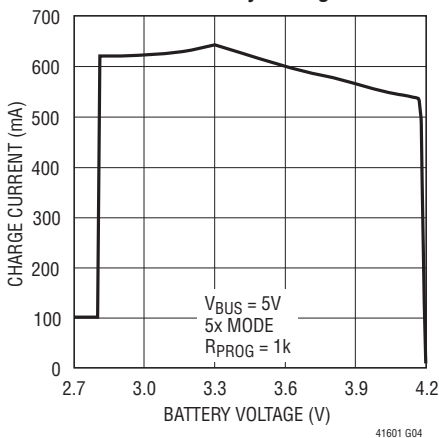**USB Limited Load Current vs Battery Voltage (Battery Charger Disabled)**
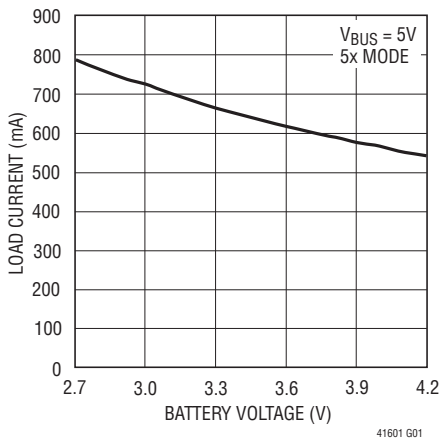
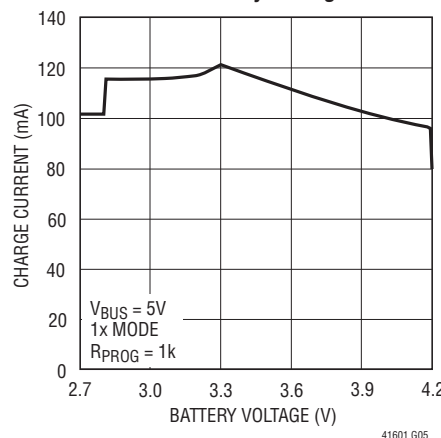**USB Limited Load Current vs Battery Voltage (Battery Charger Disabled)**

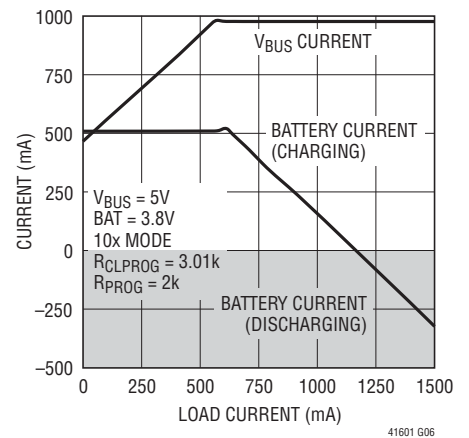**Battery and V_{BUS} Currents vs Load Current**

USB Limited Battery Charge Current vs Battery Voltage
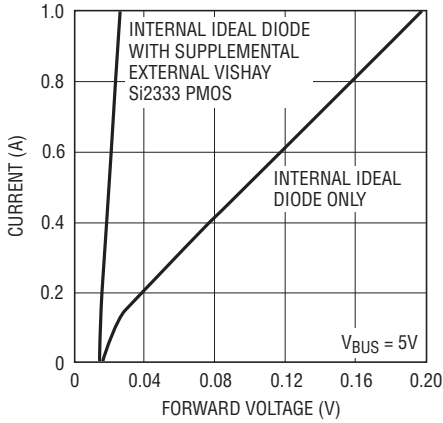

USB Limited Battery Charge Current vs Battery Voltage
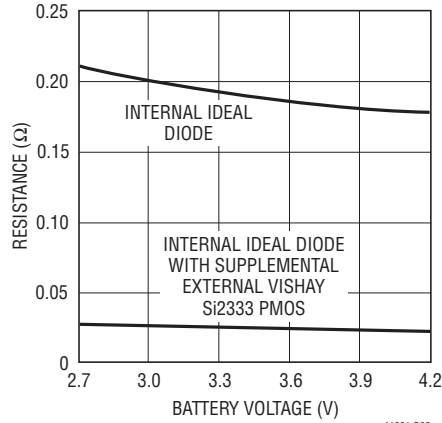

Battery and V_{BUS} Currents vs Load Current

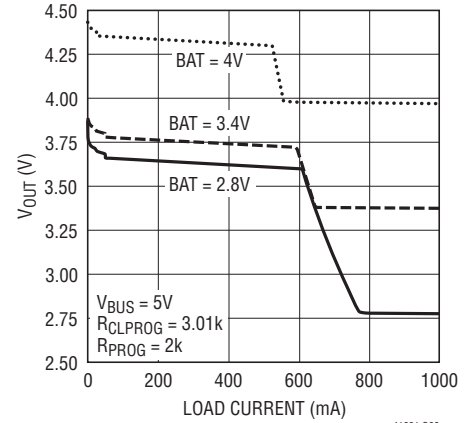# TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25°C$, unless otherwise noted.
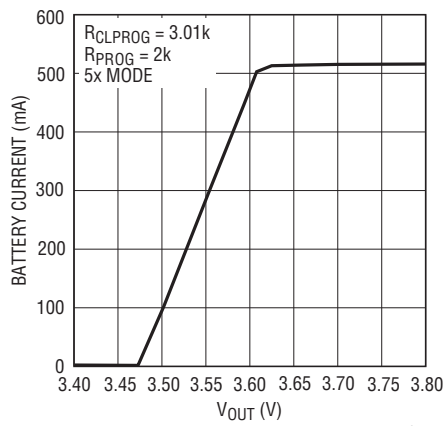
Ideal Diode V-I Characteristics

INTERNAL IDEAL DIODE WITH SUPPLEMENTAL EXTERNAL VISHAY Si2333 PMOS

INTERNAL IDEAL DIODE ONLY

$V_{BUS} = 5V$

CURRENT (A) vs FORWARD VOLTAGE (V)

41601 G07

Ideal Diode Resistance vs Battery Voltage

INTERNAL IDEAL DIODE

INTERNAL IDEAL DIODE WITH SUPPLEMENTAL EXTERNAL VISHAY Si2333 PMOS

RESISTANCE (Ω) vs BATTERY VOLTAGE (V)

41601 G08

V_{OUT} Voltage vs Load Current (Battery Charger Disabled)

BAT = 4V
BAT = 3.4V
BAT = 2.8V

$V_{BUS} = 5V$
$R_{CLPROG} = 3.01k$
$R_{PROG} = 2k$

V_{OUT} (V) vs LOAD CURRENT (mA)

41601 G09

Battery Charge Current vs V_{OUT} Voltage

$R_{CLPROG} = 3.01k$
$R_{PROG} = 2k$
5x MODE

BATTERY CURRENT (mA) vs V_{OUT} (V)

41601 G10

V_{OUT} Voltage vs Battery Voltage (Charger Overprogrammed)

$V_{BUS} = 5V$
$I_{VOUT} = 0\mu A$
$R_{CLPROG} = 3.01k$
$R_{PROG} = 1k$

5x MODE
1x MODE
BATTERY VOLTAGE

V_{OUT} (V) vs BATTERY VOLTAGE (V)

41601 G11
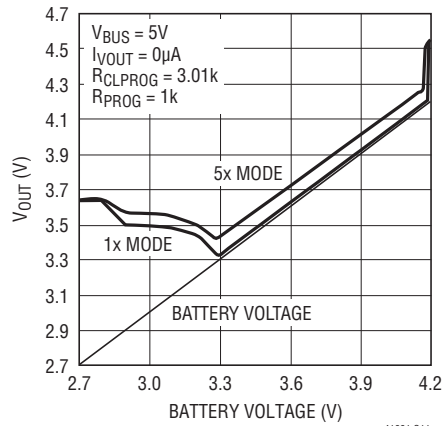
V_{OUT} Voltage vs Load Current (Battery Charger Enabled)

BAT = 4V
BAT = 3.4V
BAT = 2.8V

$V_{BUS} = 5V$
$R_{CLPROG} = 3.01k$
$R_{PROG} = 2k$

V_{OUT} (V) vs LOAD CURRENT (mA)

41601 G12
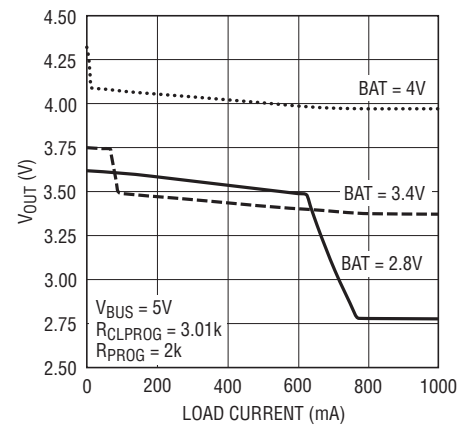
PowerPath Switching Regulator Transient Response

V_{OUT} 50mV/DIV AC-COUPLED

I_{VOUT} 500mA/DIV

0mA

$V_{BUS} = 5V$
$V_{OUT} = 3.65V$
CHARGER OFF
10x MODE

20μs/DIV

41601 G13
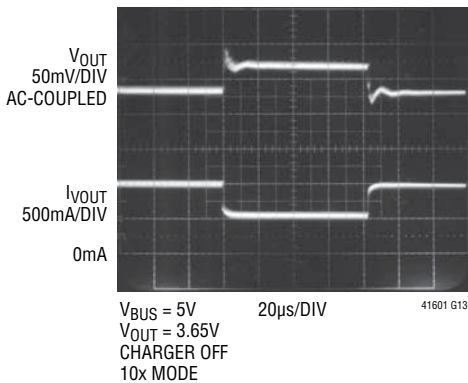
PowerPath Switching Regulator Efficiency vs Load Current

1x MODE
5x, 10x MODE

EFFICIENCY (%) vs LOAD CURRENT (mA)

41601 G14
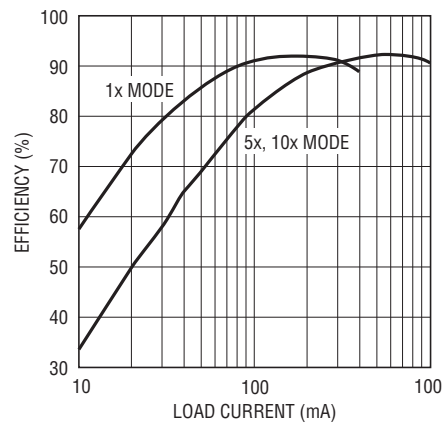
Battery Charging Efficiency vs Battery Voltage with No External Load (P_{BAT}/P_{VBUS})

$R_{CLPROG} = 3.01k$
$R_{PROG} = 1k$

1x MODE
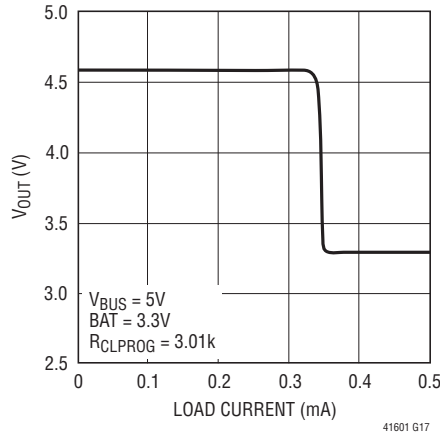5x MODE

EFFICIENCY (%) vs BATTERY VOLTAGE (V)

41601 G15

41601f

6
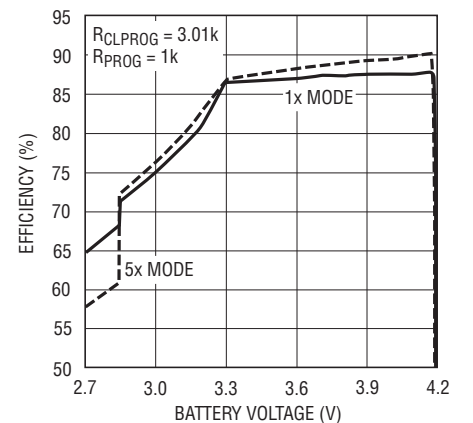
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25°C$, unless otherwise noted.

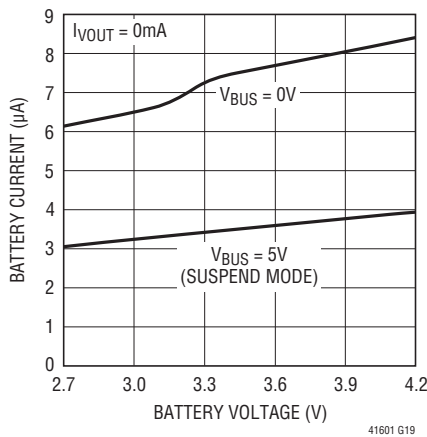**V_{BUS} Quiescent Current vs V_{BUS} Voltage (Suspend)**

41601 G16
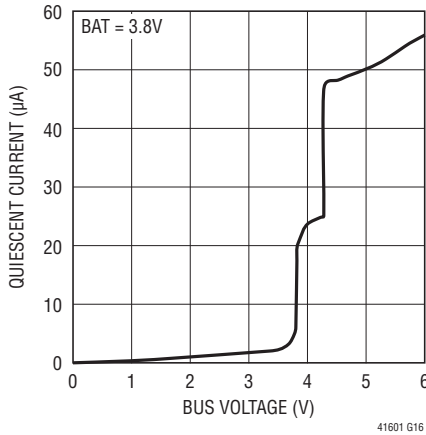
V_{OUT} Voltage vs Load Current in Suspend

41601 G17

V_{BUS} Current vs Load Current in Suspend

41601 G18
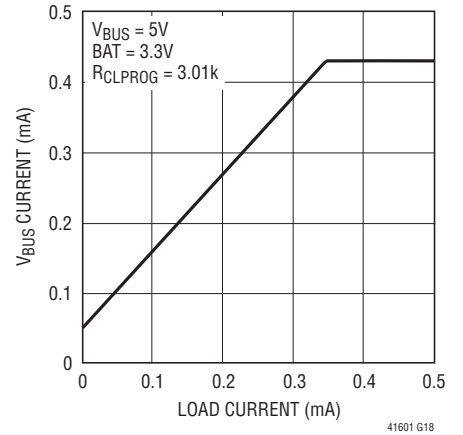
Battery Drain Current vs Battery Voltage

41601 G19

Battery Charge Current vs Temperature

41601 G20
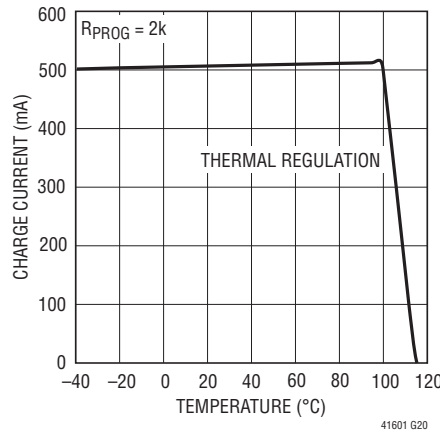
Normalized Battery Charger Float Voltage vs Temperature

41601 G21

V_{BUS} Quiescent Current vs Temperature

41601 G22
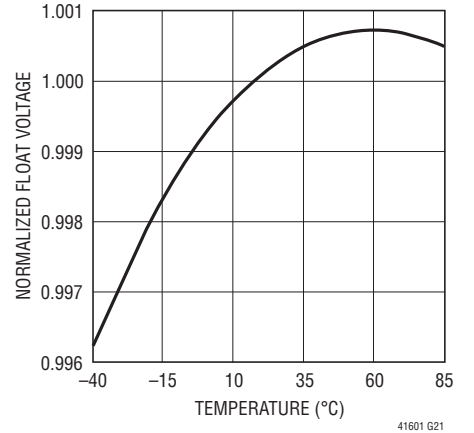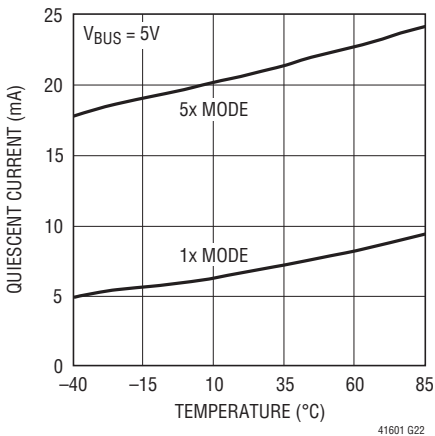
V_{BUS} Quiescent Current in Suspend vs Temperature

41601 G23
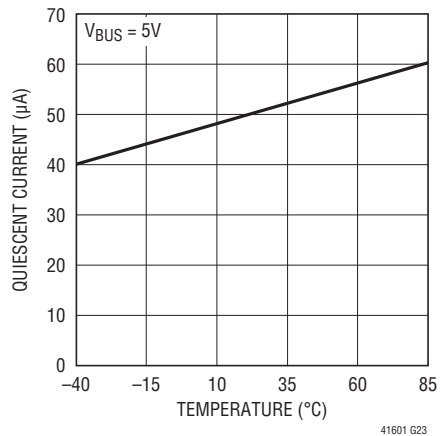
Battery Drain Current vs Temperature

41601 G24

41601f
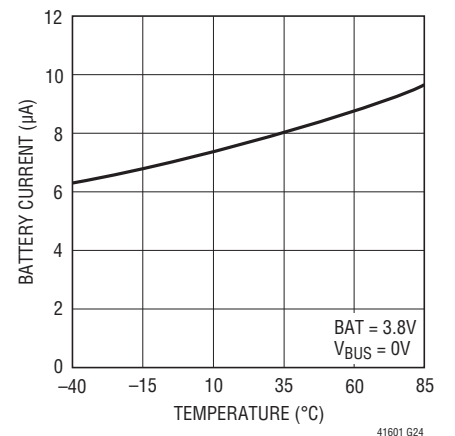
TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

OTG Boost Quiescent Current vs Battery Voltage

41601 G25
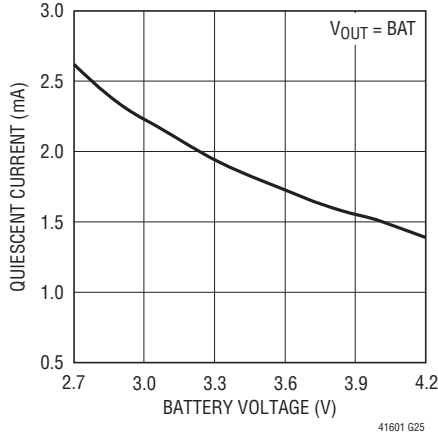
OTG Boost V_{BUS} Voltage vs Load Current

41601 G26
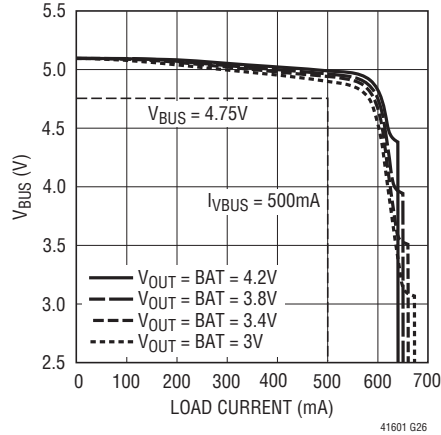
OTG Boost Efficiency vs Load Current

41601 G27
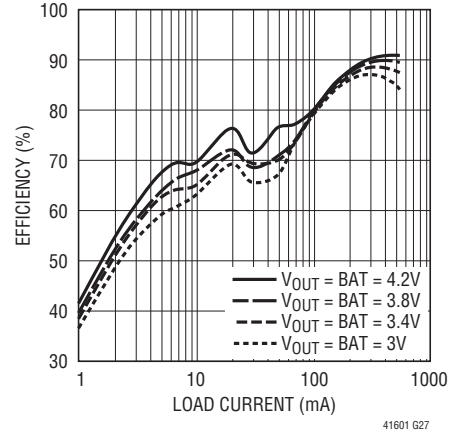
OTG Boost Efficiency vs Battery Voltage

41601 G28
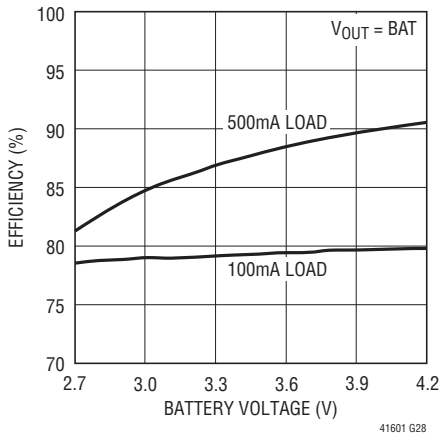
OTG Boost Start-Up Time into Current Source Load vs Battery Voltage

41601 G29
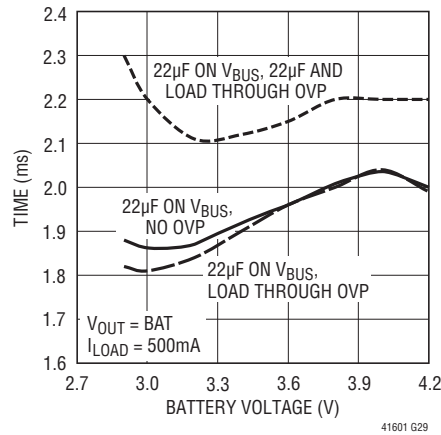
OTG Boost Burst Mode Current Threshold vs Battery Voltage

41601 G30
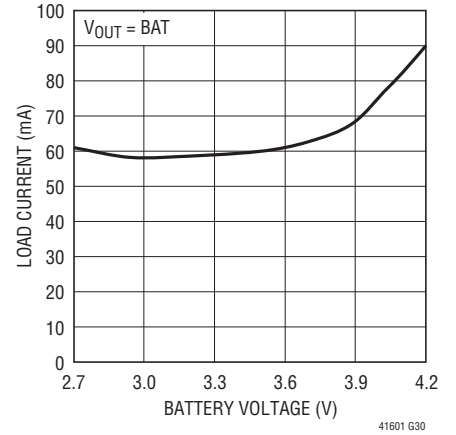
OTG Boost Transient Response

V_{OUT} = 3.8V   20μs/DIV

41601 G31
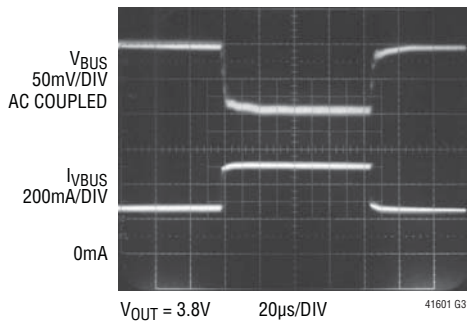
OTG Boost Start-Up into Current Source Load

V_{OUT} = 3.8V   200μs/DIV
I_{LOAD} = 500mA

41601 G32
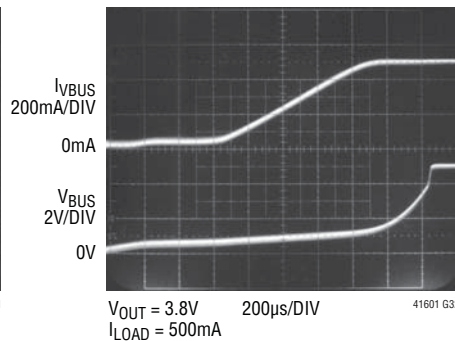
OTG Boost Burst Mode Operation

V_{OUT} = 3.8V   50μs/DIV
I_{LOAD} = 10mA

41601 G33

41601f

8
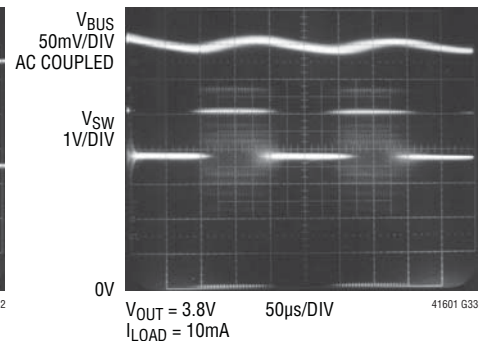
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25°C$, unless otherwise noted.

3.3V LDO Output Voltage vs Load Current, $V_{BUS} = 0V$

41601 G34
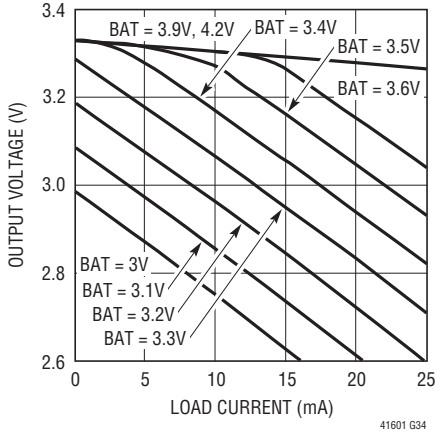
3.3V LDO Step Response (5mA to 15mA)

BAT = 3.8V   20µs/DIV

41601 G35
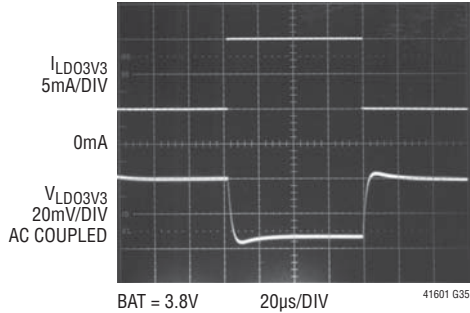
Oscillator Frequency vs Temperature

41601 G36
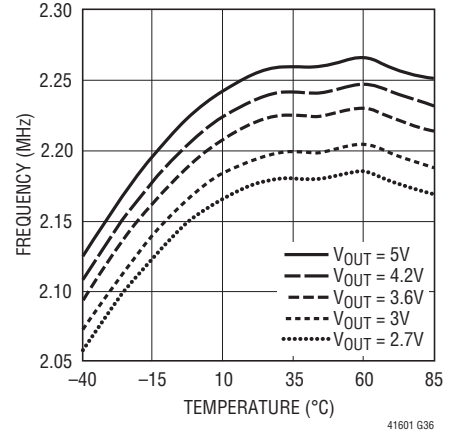
OVP Connect Waveform

250µs/DIV   41601 G37
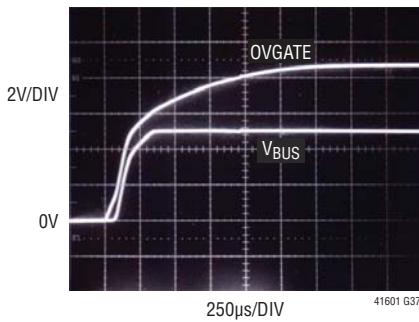
OVP Disconnect Waveform

500µs/DIV   41601 G38
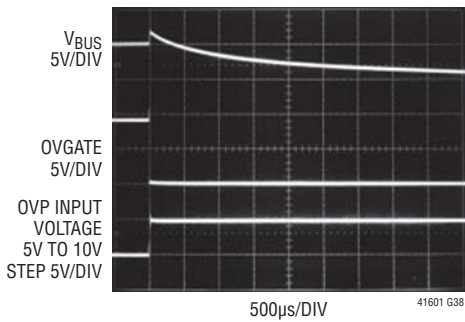
Rising OVP Threshold vs Temperature

41601 G39

OVGATE vs OVSENS

41601 G40
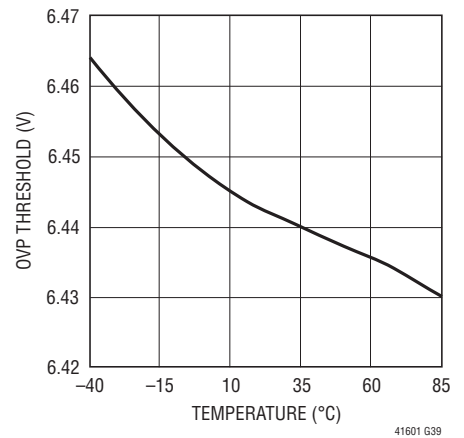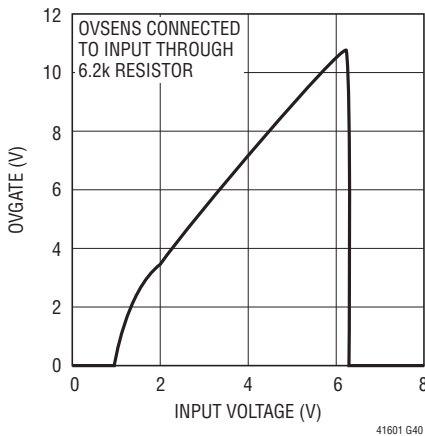
OVSENS Quiescent Current vs Temperature

41601 G41
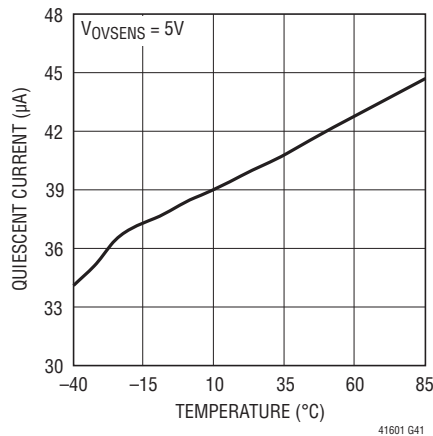
$\overline{VBUSGD}$, $\overline{CHRG}$, $\overline{FAULT}$ Pin Current vs Voltage (Pull-Down State)

41601 G42

41601f

9
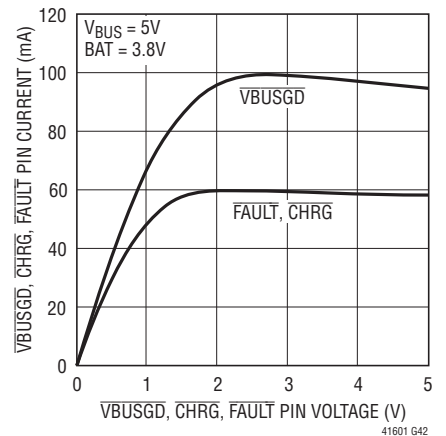
PIN FUNCTIONS

OVGATE (Pin 1): Overvoltage Protection Gate Output. Connect OVGATE to the gate pin of an external N-channel MOSFET. The source of the transistor should be connected to V_{BUS} and the drain should be connected to the product's DC input connector. In the absence of an overvoltage condition, this pin is connected to an internal charge pump capable of creating sufficient overdrive to fully enhance the MOSFET. If an overvoltage condition is detected, OVGATE is brought rapidly to GND to prevent damage to the LTC4160/LTC4160-1. OVGATE works in conjunction with OVSENS to provide this protection.

OVSENS (Pin 2): Overvoltage Protection Sense Input. OVSENS should be connected through a 6.2k resistor to the input power connector and the drain of an external N-channel MOSFET. When the voltage on this pin exceeds $V_{OVCUTOFF,}$ the OVGATE pin will be pulled to GND to disable the MOSFET and protect the LTC4160/LTC4160-1. The OVSENS pin shunts current during an overvoltage transient in order to keep the pin voltage at 6V.

$\overline{VBUSGD}$ (Pin 3): Logic Output. This is an open-drain output which indicates that V_{BUS} is above V_{UVLO} and V_{DUVLO}. $\overline{VBUSGD}$ requires a pull-up resistor and/or LED to provide indication.

$\overline{FAULT}$ (Pin 4): Logic Output. This in an open-drain output which indicates a bad battery fault when the charger is enabled or a short circuit condition on V_{BUS} when the bidirectional PowerPath switching regulator is in step-up mode (On-The-Go). $\overline{FAULT}$ requires a pull-up resistor and/or LED to provide indication.

ID (Pin 5): Logic Input. This pin independently enables the bidirectional switching regulator to step-up the voltage on V_{OUT} and provide a 5V output on the V_{BUS} pin for USB On-The-Go applications. If the host does not power down V_{BUS} then connect this pin directly to the ID pin of a USB micro-AB receptacle. Active low. Has an internal 2.5µA pull-up current source.

ENOTG (Pin 6): Logic Input. This pin independently enables the bidirectional switching regulator to step-up the voltage on V_{OUT} and provide a 5V output on the V_{BUS} pin for USB On-The-Go applications. Active high. Has an internal 1.8µA pull-down current source.

$\overline{ENCHARGER}$ (Pin 7): Logic Input. This pin enables the battery charger. Active low. Has an internal 1.8µA pull-down current source.

PROG (Pin 8): Charge Current Program and Charge Current Monitor Pin. Connecting a 1% resistor from PROG to ground, programs the charge current. If sufficient input power is available in constant-current mode, this pin servos to 1V. The voltage on this pin always represents the actual charge current by using the following formula:

$$I_{BAT} = \frac{V_{PROG}}{R_{PROG}} \cdot 1030$$

$\overline{CHRG}$ (Pin 9): Logic Output. This is an open-drain output that indicates whether the battery is charging or not charging. $\overline{CHRG}$ requires a pull-up resistor and/or LED to provide indication.

IDGATE (Pin 10): Ideal Diode Amplifier Output. This pin controls the gate of an optional external P-channel MOSFET used as an ideal diode between V_{OUT} and BAT. The external ideal diode operates in parallel with the internal ideal diode. The source of the P-channel MOSFET should be connected to V_{OUT} and the drain should be connected to BAT. If the external ideal diode MOSFET is not used, IDGATE should be left floating.

BAT (Pin 11): Single Cell Li-Ion Battery Pin. Depending on available V_{BUS} power, a Li-Ion battery on BAT will either deliver power to V_{OUT} through the ideal diode or be charged from V_{OUT} via the battery charger.

V_{OUT} (Pin 12): Output Voltage of the Bidirectional Power-Path Switching Regulator in Step-Down Mode and Input Voltage of the Battery Charger. The majority of the portable product should be powered from V_{OUT}. The LTC4160/LTC4160-1 will partition the available power between the external load on V_{OUT} and the internal battery charger. Priority is given to the external load and any extra power is used to charge the battery. An ideal diode from BAT to V_{OUT} ensures that V_{OUT} is powered even if the load exceeds the allotted power from V_{BUS} or if the V_{BUS} power source is removed. In On-The-Go mode, this pin delivers power to V_{BUS} via the SW pin. V_{OUT} should be bypassed with a

41601f

10

PIN FUNCTIONS

low impedance multilayer ceramic capacitor.

V_{BUS} (Pin 13): Power Pin. This pin delivers power to V_{OUT} via the SW pin by drawing controlled current from a DC source such as a USB port or DC output wall adapter. In On-The-Go mode this pin provides power to external loads. Bypass V_{BUS} with a low impedance multilayer ceramic capacitor.

SW (Pin 14): The SW pin transfers power between V_{BUS} to V_{OUT} via the bidirectional switching regulator. See the Applications Information section for a discussion of inductance value and current rating.

I_{LIM0}, I_{LIM1} (Pins 15, 16): I_{LIM0} and I_{LIM1} control the V_{BUS} input current limit of the bidirectional PowerPath switching regulator in step-down mode. See Table 1. Each has an internal 1.8µA pull-down current source.

CLPROG (Pin 17): USB Current Limit Program and Monitor Pin. A 1% resistor from CLPROG to ground determines the upper limit of the current drawn or sourced from the V_{BUS} pin. A precise fraction, h_{CLPROG}, of the V_{BUS} current is sent to the CLPROG pin when the PMOS switch of the bidirectional PowerPath switching regulator is on. The switching regulator delivers power until the CLPROG pin reaches 1.18V in step-down mode and 1.15V in step-up mode. When the switching regulator is in step-down mode, CLPROG is used to regulate the average input current. Several V_{BUS} current limit settings are available via user input which will typically correspond to the 500mA and 100mA USB specifications. When the switching regulator is in step-up mode (USB On-The-Go), CLPROG is used to limit the average output current to 680mA. A multilayer ceramic averaging capacitor or R-C network is required at CLPROG for filtering.

LDO3V3 (Pin 18): 3.3V LDO Output Pin. This pin provides a regulated always-on 3.3V supply voltage. LDO3V3 gets its power from V_{OUT}. It may be used for light loads such as a watch dog microprocessor or real time clock. A 1µF capacitor is required from LDO3V3 to ground. If the LDO3V3 output is not used it should be disabled by connecting it to V_{OUT}.

NTCBIAS (Pin 19): NTC Thermistor Bias Output. If NTC operation is desired, connect a bias resistor between NTCBIAS and NTC, and an NTC thermistor between NTC and GND. To disable NTC operation, connect NTC to GND and leave NTCBIAS open.

NTC (Pin 20): Input to the Thermistor Monitoring Circuits. The NTC pin connects to a negative temperature coefficient thermistor, which is typically co-packaged with the battery, to determine if the battery is too hot or too cold to charge. If the battery's temperature is out of range, charging is paused until it re-enters the valid range. A low drift bias resistor is required from NTCBIAS to NTC and a thermistor is required from NTC to ground. To disable NTC operation, connect NTC to GND and leave NTCBIAS open.

Exposed Pad (Pin 21): Ground. The Exposed Pad should be connected to a continuous ground plane on the second layer of the printed circuit board by several vias directly under the LTC4160/LTC4160-1.

41601f

11

LTC4160/LTC4160-1

BLOCK DIAGRAM
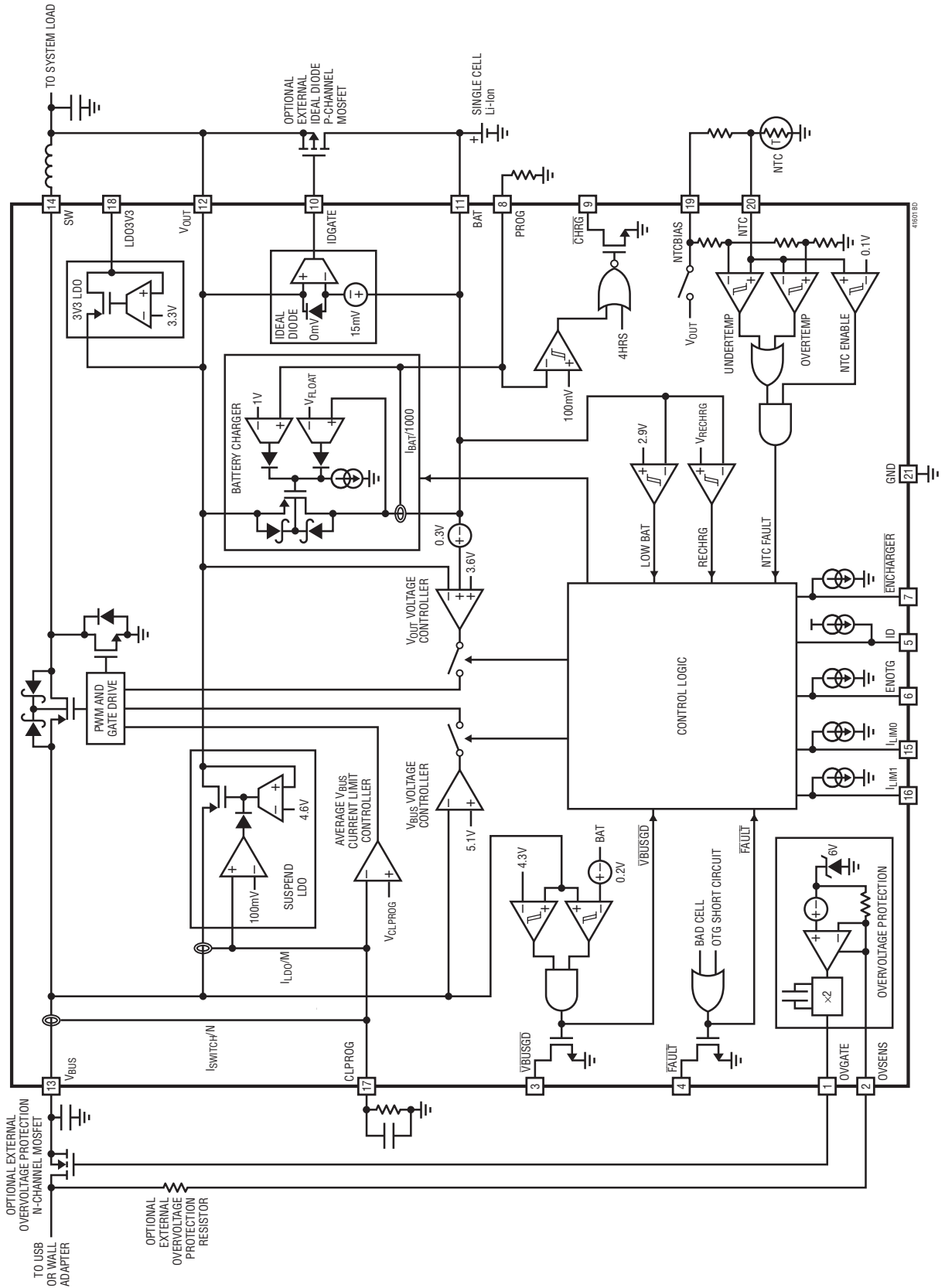
41601f

OPERATION

Introduction

The LTC4160/LTC4160-1 are high efficiency bidirectional switching power managers and Li-Ion/Polymer battery chargers designed to make optimal use of the power available while minimizing power dissipation and easing thermal budgeting constraints. The innovative PowerPath architecture ensures that the end product application is powered immediately after external voltage is applied, even with a completely dead battery, by prioritizing power to the end product.

When acting as a step-down converter, the LTC4160/LTC4160-1's bidirectional switching regulator takes power from USB, wall adapters, or other 5V sources and provides power to the end product application and efficiently charges the battery using Bat-Track. Because power is conserved, the LTC4160/LTC4160-1 allow the load current on V_{OUT} to exceed the current drawn by the USB port, making maximum use of the allowable USB power for battery charging. For USB compatibility, the switching regulator includes a precision average input current limit. The bidirectional switching regulator and battery charger communicate to ensure that the average input current never exceeds the USB specifications.

In addition, the bidirectional switching regulator can also operate as a 5V synchronous step-up converter, taking power from V_{OUT} and delivering up to 500mA to V_{BUS} without the need for any additional external components. This enables systems with USB dual-role transceivers to function as USB On-The-Go dual-role devices. True output disconnect and average output current limit features are included for short circuit protection.

The LTC4160/LTC4160-1 contain both an internal 180mΩ ideal diode as well as an ideal diode controller for use with an external P-channel MOSFET. The ideal diodes from BAT to V_{OUT} guarantee that ample power is always available to V_{OUT} even if there is insufficient or absent power at V_{BUS}.

An always-on LDO provides a regulated 3.3V from available power at V_{OUT}. Drawing very little quiescent current, this LDO will be on at all times and can be used to supply up to 20mA.

The LTC4160/LTC4160-1 also feature an overvoltage protection circuit which is designed to work with an external N-channel MOSFET to prevent damage to their inputs caused by accidental application of high voltage.

Finally, to prevent battery drain when a device is connected to a suspended USB port, an LDO from V_{BUS} to V_{OUT} provides low power USB suspend current to the end product application.

Bidirectional PowerPath Switching Regulator – Step-Down Mode

The power delivered from V_{BUS} to V_{OUT} is controlled by a 2.25MHz constant frequency bidirectional switching regulator in step-down mode. V_{OUT} drives the combination of the external load and the battery charger. To meet the maximum USB load specification, the switching regulator contains a measurement and control system that ensures that the average input current remains below the level programmed at CLPROG.

If the combined load does not cause the switching regulator to reach the programmed input current limit, V_{OUT} will track approximately 0.3V above the battery voltage. By keeping the voltage across the battery charger at this low level, power lost to the battery charger is minimized. Figure 1 shows the power flow in step-down mode.

If the combined external load plus battery charge current is large enough to cause the switching regulator to reach the programmed input current limit, the battery charger will reduce its charge current by precisely the amount necessary to enable the external load to be satisfied. Even if the battery charge current is programmed to exceed the allowable USB current, the USB specification for average input current will not be violated; the battery charger will reduce its current as needed. Furthermore, if the load current at V_{OUT} exceeds the programmed power from V_{BUS}, load current will be drawn from the battery via the ideal diode(s) even when the battery charger is enabled.

The current out of CLPROG is a precise fraction of the V_{BUS} current. When a programming resistor and an averaging capacitor are connected from CLPROG to GND, the voltage on CLPROG represents the average input current of the switching regulator. As the input current approaches

41601f

OPERATION

the programmed limit, CLPROG reaches 1.18V and power delivered by the switching regulator is held constant.

The input current limit is programmed by the I_{LIM0} and I_{LIM1} pins. The input current limit has four possible settings ranging from the USB suspend limit of 500μA up to 1A for wall adapter applications. Two of these settings are specifically intended for use in the 100mA and 500mA USB application. Refer to Table 1 for current limit settings using I_{LIM0} and I_{LIM1}.

Table 1. USB Current Limit Settings Using I_{LIM0} and I_{LIM1}

I_{LIM1}	I_{LIM0}	USB SETTING
0	0	1x Mode (USB 100mA Limit)
0	1	10x Mode (Wall 1A Limit)
1	0	Low Power Suspend (USB 500μA Limit)
1	1	5x Mode (USB 500mA Limit)

When the switching regulator is activated, the average input current will be limited by the CLPROG programming resistor according to the following expression:

$$I_{VBUS} = I_{VBUSQ} + \frac{V_{CLPROG}}{R_{CLPROG}} \bullet (h_{CLPROG} + 1)$$

where I_{VBUSQ} is the quiescent current of the LTC4160/LTC4160-1, V_{CLPROG} is the CLPROG servo voltage in current limit, R_{CLPROG} is the value of the programming resistor and h_{CLPROG} is the ratio of the measured current at V_{BUS} to the sample current delivered to CLPROG. Refer to the Electrical Characteristics table for values of h_{CLPROG}, V_{CLPROG} and I_{VBUSQ}. Given worst-case circuit tolerances, the USB specification for the average input current in 100mA or 500mA mode will not be violated, provided that R_{CLPROG} is 3.01k or greater.

While not in current limit, the switching regulator's Bat-Track feature will set V_{OUT} to approximately 300mV above the voltage at BAT. However, if the voltage at BAT is below 3.3V, and the load requirement does not cause the switching regulator to exceed its current limit, V_{OUT} will regulate at a fixed 3.6V, as shown in Figure 2. This instant-on operation will allow a portable product to run immediately when power is applied without waiting for the battery to charge. If the load does exceed the current limit at V_{BUS}, V_{OUT} will range between the no-load voltage and slightly below the battery voltage, indicated by the shaded region of Figure 2.
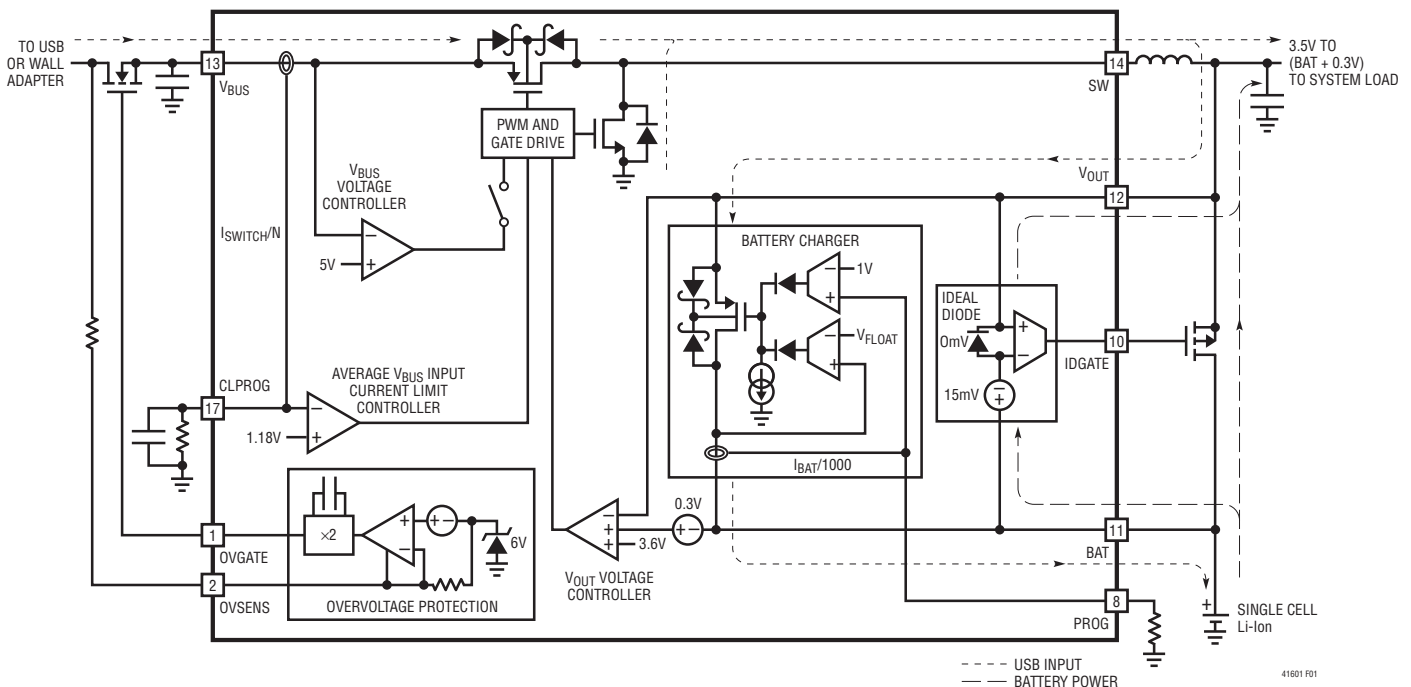
Figure 1. Power Path Block Diagram – Power Available from USB/Wall Adapter

41601f

OPERATION

For very low-battery voltages, the battery charger acts like a load and, due to limited input power, its current will tend to pull V_{OUT} below the 3.6V instant-on voltage. To prevent V_{OUT} from falling below this level, an undervoltage circuit automatically detects that V_{OUT} is falling and reduces the battery charge current as needed. This reduction ensures that load current and voltage are always prioritized while allowing as much battery charge current as possible. See Over Programming the Battery Charger in the Applications Information section.

The voltage regulation loop compensation is controlled by the capacitance on V_{OUT}. A multilayer ceramic capacitor of 10µF is required for loop stability. Additional capacitance beyond this value will improve transient response.

An internal undervoltage lockout circuit monitors V_{BUS} and keeps the switching regulator off until V_{BUS} rises above 4.30V and is about 200mV above the battery voltage. When both conditions are met, $\overline{VBUSGD}$ goes low and the switching regulator turns on. Hysteresis on the UVLO forces $\overline{VBUSGD}$ high and turns off the switching regulator if V_{BUS} falls below 4.00V or to within 50mV of the battery voltage. When this happens, system power at V_{OUT} will be drawn from the battery via the ideal diode(s).
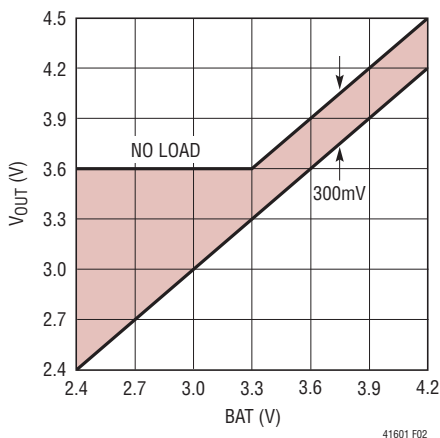
Figure 2. V_{OUT} vs BAT

Bidirectional PowerPath Switching Regulator – Step-Up Mode

For USB On-The-Go applications, the bidirectional PowerPath switching regulator acts as a step-up converter to deliver power from V_{OUT} to V_{BUS}. The power from V_{OUT} comes from the battery via the ideal diode(s). As a step-up converter, the bidirectional switching regulator produces 5V on V_{BUS} and is capable of delivering at least 500mA. USB On-The-Go can be enabled by either of the external control pins, ENOTG or ID. Figure 3 shows the power flow in step-up mode.

An undervoltage lockout circuit monitors V_{OUT} and prevents step-up conversion until V_{OUT} rises above 2.8V. To prevent backdriving of V_{BUS} when input power is available, the V_{BUS} undervoltage lockout circuit prevents step-up conversion if V_{BUS} is already greater than 4.3V at the time step-up mode is enabled. The switching regulator is also designed to allow true output disconnect by eliminating body diode conduction of the internal PMOS switch. This allows V_{BUS} to go to zero volts during a short-circuit condition or while shutdown, drawing zero current from V_{OUT}.

The voltage regulation loop is compensated by the capacitance on V_{BUS}. A 4.7µF multilayer ceramic capacitor is required for loop stability. Additional capacitance beyond this value will improve transient response. The V_{BUS} voltage has approximately 3% load regulation up to an output current of 500mA. At light loads, the switching regulator goes into Burst Mode® operation. The regulator will deliver power to V_{BUS} until it reaches 5.1V after which the NMOS and PMOS switches shut off. The regulator delivers power again to V_{BUS} once it falls below 5.1V.

The switching regulator features both peak inductor and average output current limit. The peak current-mode architecture limits peak inductor current on a cycle-by-cycle basis. The peak current limit is equal to $V_{BUS}/2\Omega$ to a maximum of 1.8A so that in the event of a sudden short circuit, the current limit will fold back to a lower value. In step-up mode, the voltage on CLPROG represents the average output current of the switching regulator when a programming resistor and an averaging capacitor are connected from CLPROG to GND. With a 3.01k resistor on CLPROG, the bidirectional switching regulator has an output current limit of 680mA. As the output current approaches this limit, CLPROG servos to 1.15V and V_{BUS} falls rapidly to V_{OUT}. When V_{BUS} is close to V_{OUT} there may not be sufficient negative slope on the inductor current when the PMOS switch is on to balance the rise in the inductor

Burst Mode is a registered trademark of Linear Technology Corporation.

41601f

OPERATION
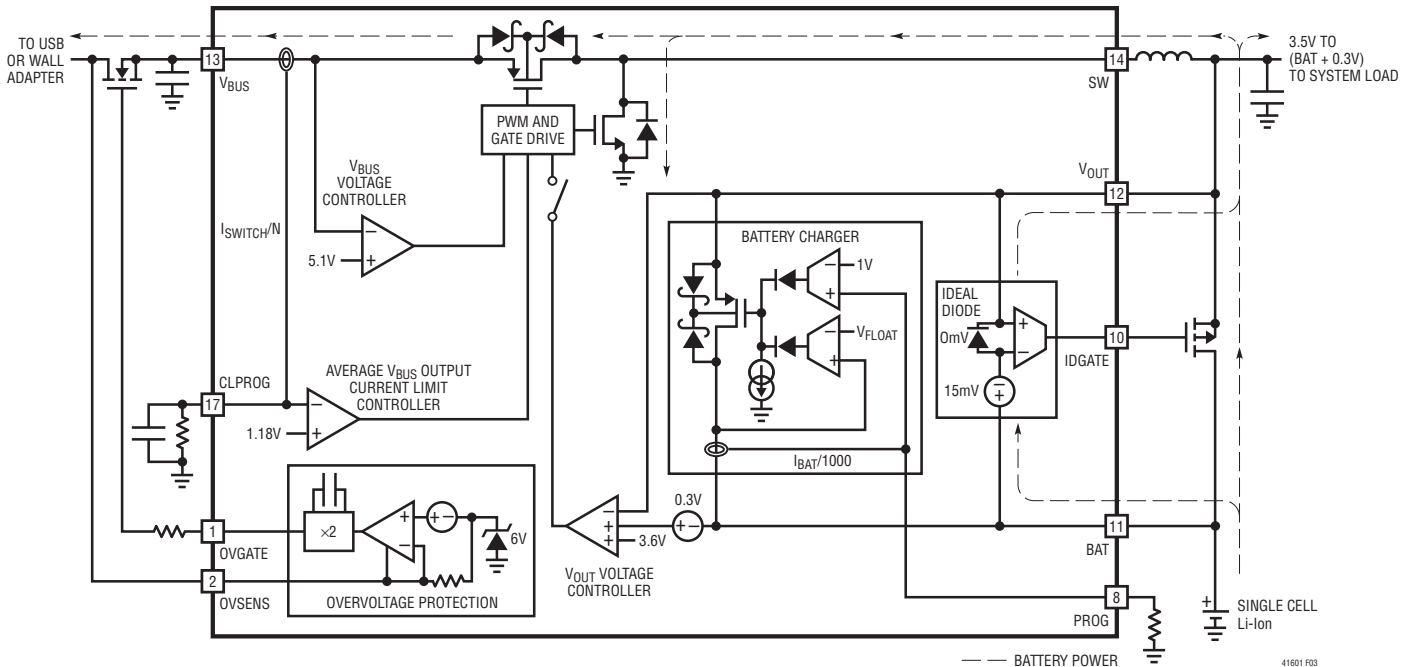
Figure 3. PowerPath Block Diagram – USB On-The-Go

current when the NMOS switch is on. This will cause the inductor current to run away and the voltage on CLPROG to rise. When CLPROG reaches 1.2V the switching of the synchronous PMOS is terminated and V_{OUT} is applied statically to its gate. This ensures that the inductor current will have sufficient negative slope during the time current is flowing out of the V_{BUS} pin. The PMOS will resume switching when CLPROG drops down to 1.15V.

The PMOS switch is enabled when V_{BUS} rises above V_{OUT} + 180mV and is disabled when it falls below V_{OUT} + 70mV to prevent the inductor current from running away when not in current limit. If the PMOS switch is disabled for more than 7.2ms then the switcher will shut off, the $\overline{FAULT}$ pin will go low and a short circuit fault will be declared. To re-enable step-up mode, the ENOTG pin, with ID high, must be cycled low and then high or the ID pin, with ENOTG grounded, must be cycled high and then low.

Ideal Diode(s) from BAT to V_{OUT}

The LTC4160/LTC4160-1 each have an internal ideal diode as well as a controller for an external ideal diode. Both the internal and the external ideal diodes are always on and will respond quickly whenever V_{OUT} drops below BAT.

If the load current increases beyond the power allowed from the bidirectional switching regulator, additional power will be pulled from the battery via the ideal diode(s). Furthermore, if power to V_{BUS} (USB or wall adapter) is removed, then all of the application power will be provided by the battery via the ideal diode(s). The ideal diode(s) will prevent V_{OUT} from drooping with only the storage capacitance required for the bidirectional switching regulator. The internal ideal diode consists of a precision amplifier that activates a large on-chip P-channel MOSFET whenever
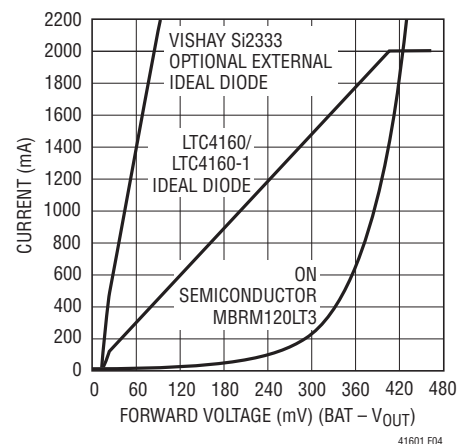
Figure 4. Ideal Diode V-I Characteristics

41601f

OPERATION

the voltage at V_{OUT} is approximately 15mV (V_{FWD}) below the voltage at BAT. Within the amplifier's linear range, the small-signal resistance of the ideal diode will be quite low, keeping the forward drop near 15mV. At higher current levels, the MOSFET will be in full conduction.

To supplement the internal ideal diode, an external P-channel MOSFET may be added from BAT to V_{OUT}. The IDGATE pin of the LTC4160/LTC4160-1 drives the gate of the external P-channel MOSFET for automatic ideal diode control. The source of the external P-channel MOSFET should be connected to V_{OUT} and the drain should be connected to BAT. Capable of driving a 1nF load, the IDGATE pin can control an external P-channel MOSFET having an on-resistance of 30mΩ or lower.

Suspend LDO

If the LTC4160/LTC4160-1 is configured for USB suspend mode, the bidirectional switching regulator is disabled and the suspend LDO provides power to the V_{OUT} pin (presuming there is power available at V_{BUS}). This LDO will prevent the battery from running down when the portable product has access to a suspended USB port. Regulating at 4.6V, this LDO only becomes active when the bidirectional switching regulator is disabled (suspended). The suspend LDO sends a scaled copy of the V_{BUS} current to the CLPROG pin, which will servo to approximately 100mV in this mode. In accordance with the USB specification, the input to the LDO is current limited so that it will not exceed the low power suspend specification. If the load on V_{OUT} exceeds the suspend current limit, the additional current will come from the battery via the ideal diode(s).

3.3V Always-On LDO Supply

The LTC4160/LTC4160-1 include a low quiescent current low dropout regulator that is always powered. This LDO can be used to provide power to a system pushbutton controller, standby microcontroller or real time clock. Designed to deliver up to 20mA, the always-on LDO requires at least a 1μF multilayer ceramic bypass capacitor for compensation. The LDO is powered from V_{OUT}, and therefore will enter dropout at loads less than 20mA as V_{OUT} falls near 3.3V. If the LDO3V3 output is not used, it should be disabled by connecting it to V_{OUT}.

Battery Charger

The LTC4160/LTC4160-1 include a constant-current/constant-voltage battery charger with automatic recharge, automatic termination by safety timer, low voltage trickle charging, bad cell detection, and thermistor sensor input for out-of-temperature charge pausing. The charger can be disabled using the $\overline{ENCHARGER}$ pin.

Battery Preconditioning

When a battery charge cycle begins, the battery charger first determines if the battery is deeply discharged. If the battery voltage is below V_{TRKL}, typically 2.85V, an automatic trickle charge feature sets the battery charge current to 10% of the programmed value. If the low voltage persists for more than a 1/2 hour, the battery charger automatically terminates and indicates via the $\overline{CHRG}$ and $\overline{FAULT}$ pins that the battery was unresponsive.

Once the battery voltage is above 2.85V, the charger begins charging in full power constant-current mode. The current delivered to the battery will try to reach $1030/R_{PROG}$. Depending on available input power and external load conditions, the battery charger may or may not be able to charge at the full programmed rate. The external load will always be prioritized over the battery charge current. Likewise, the USB current limit programming will always be observed and only additional power will be available to charge the battery. When system loads are light, battery charge current will be maximized.

Charge Termination

The battery charger has a built-in safety timer. When the voltage on the battery reaches the pre-programmed float voltage, the battery charger will regulate the battery voltage and the charge current will decrease naturally. Once the battery charger detects that the battery has reached the float voltage, the four hour safety timer is started. After the safety timer expires, charging of the battery will discontinue and no more current will be delivered.

Automatic Recharge

After the battery charger terminates, it will remain off drawing only microamperes of current from the battery. If the portable product remains in this state long enough,

41601f

OPERATION

the battery will eventually self discharge. To ensure that the battery is always topped off, a charge cycle will automatically begin when the battery voltage falls below the recharge threshold which is typically 100mV less than the charger's float voltage. In the event that the safety timer is running when the battery voltage falls below the recharge threshold, it will reset back to zero. To prevent brief excursions below the recharge threshold from resetting the safety timer, the battery voltage must be below the recharge threshold for more than 1ms. The charge cycle and safety timer will also restart if the V_{BUS} UVLO cycles low and then high (e.g., V_{BUS} is removed and then replaced), or if the battery charger is cycled on and off by the $\overline{ENCHARGER}$ pin.

Charge Current

The charge current is programmed using a single resistor from PROG to ground. 1/1030th of the battery charge current is sent to PROG, which will attempt to servo to 1.000V. Thus, the battery charge current will try to reach 1030 times the current in the PROG pin. The program resistor and the charge current are calculated using the following equation:

$$I_{CHG} = \frac{V_{PROG}}{R_{PROG}} \bullet 1030$$

In either the constant-current or constant-voltage charging modes, the voltage at the PROG pin will be proportional to the actual charge current delivered to the battery. Therefore, the actual charge current can be determined at any time by monitoring the PROG pin voltage and using the following equation:

$$I_{BAT} = \frac{V_{PROG}}{R_{PROG}} \bullet 1030$$

In many cases, the actual battery charge current, I_{BAT}, will be lower than I_{CHG} due to limited input power available and prioritization with the system load drawn from V_{OUT}.

The Battery Charger Flow Chart on the next page illustrates the battery charger's algorithm.

Charge Status Indication

The $\overline{CHRG}$ and $\overline{FAULT}$ pins can be used to indicate the status of the battery charger. Two possible states are represented by $\overline{CHRG}$: charging and not charging. An open-drain output, the $\overline{CHRG}$ pin can drive an indicator LED through a current limiting resistor for human interfacing or simply a pull-up resistor for microprocessor interfacing.

When charging begins, $\overline{CHRG}$ is pulled low and remains low for the duration of a normal charge cycle. When charging is complete, i.e., the BAT pin reaches the float and the charge current has dropped to one tenth of the programmed value, the $\overline{CHRG}$ pin goes high. The $\overline{CHRG}$ pin does not respond to the C/10 threshold if the LTC4160/LTC4160-1 is in V_{BUS} input current limit. This prevents false end-of-charge indications due to insufficient power available to the battery charger.

Table 2 illustrates the possible states of the $\overline{CHRG}$ and $\overline{FAULT}$ pins when the battery charger is active.

Table 2. Charge Status Readings Using the $\overline{CHRG}$ and $\overline{FAULT}$ Pins

STATUS	$\overline{CHRG}$	$\overline{FAULT}$
Charging/NTC Fault	Low	High
Not Charging	High	High
Bad Battery	High	Low

An NTC fault pauses charging while the battery temperature is out of range but is not indicated using the $\overline{CHRG}$ or $\overline{FAULT}$ pins.

If a battery is found to be unresponsive to charging (i.e., its voltage remains below 2.85V for 1/2 hour) the $\overline{CHRG}$ pin goes high and the $\overline{FAULT}$ pin goes low to indicate a bad battery fault.

Note that the LTC4160/LTC4160-1 are 3-terminal PowerPath products where system load is always prioritized over battery charging. Due to excessive system load, there may not be sufficient power to charge the battery beyond the trickle charge threshold voltage within the bad battery timeout period. In this case, the battery charger will falsely indicate a bad battery. System software may then reduce the load and reset the battery charger to try again.

The $\overline{FAULT}$ pin is also used to indicate whether there is a short circuit condition on V_{BUS} when the bidirectional

41601f

OPERATION

Battery Charger Flow Chart
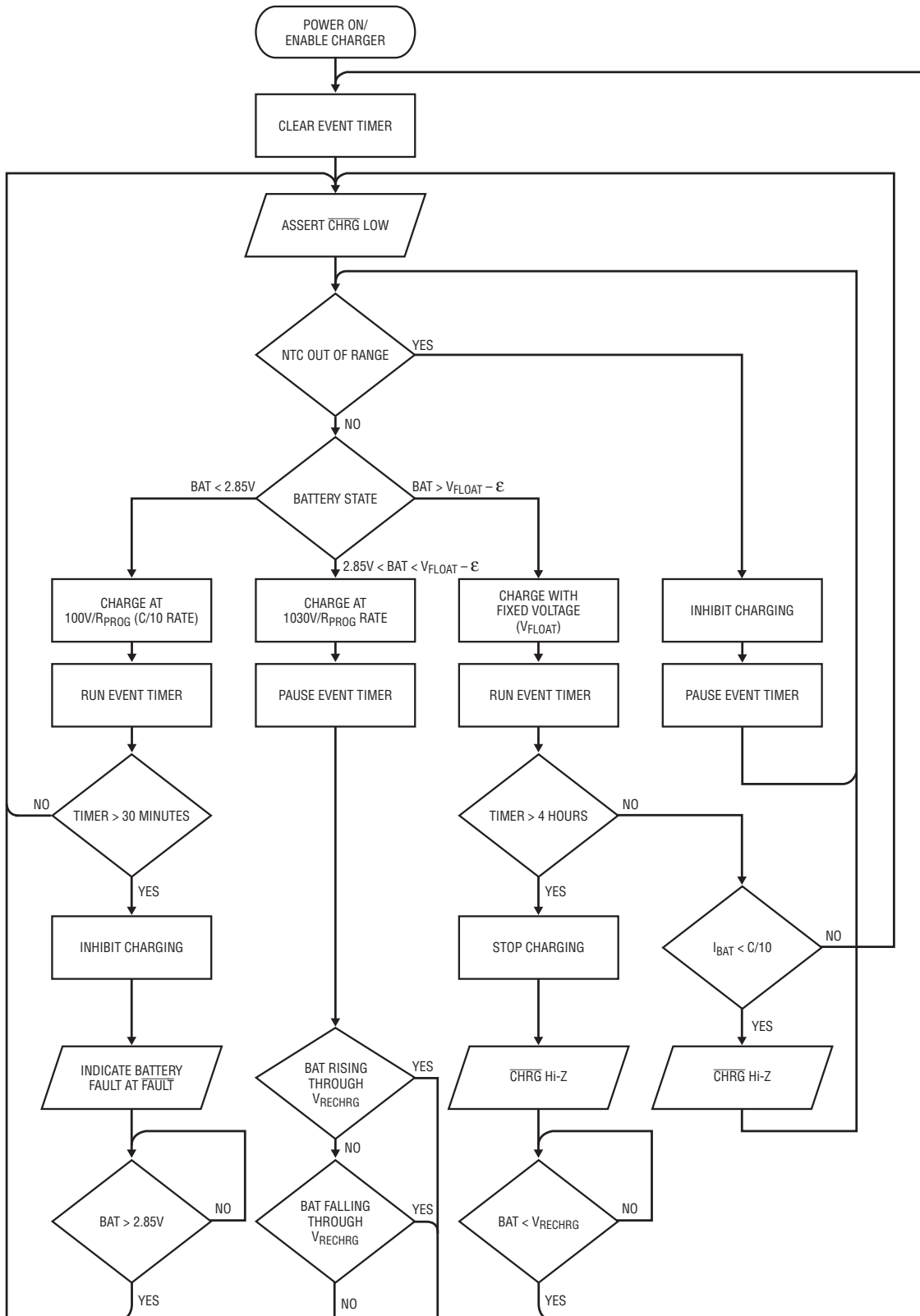
41601f

OPERATION

switching regulator is in On-The-Go mode. When a short circuit condition is detected, $\overline{FAULT}$ will go low-Z. The ENOTG or $\overline{VBUSGD}$ pins can be used to determine which fault has occurred. If ENOTG or $\overline{VBUSGD}$ is low when $\overline{FAULT}$ went low, then a bad battery fault has occurred. If either pin is high, then a short circuit on V_{BUS} has occurred.

NTC Thermistor

The battery temperature is measured by placing a negative temperature coefficient (NTC) thermistor close to the battery pack.

To use this feature connect the NTC thermistor, R_{NTC}, between the NTC pin and ground and a bias resistor, R_{NOM}, from NTCBIAS to NTC. R_{NOM} should be a 1% 200ppm resistor with a value equal to the value of the chosen NTC thermistor at 25°C (R25).

The LTC4160/LTC4160-1 will pause charging when the resistance of the NTC thermistor drops to 0.54 times the value of R25 or approximately 54k for a 100k thermistor. For a Vishay Curve 1 thermistor, this corresponds to approximately 40°C. If the battery charger is in constant-voltage (float) mode, the safety timer also pauses until the thermistor indicates a return to a valid temperature. As the temperature drops, the resistance of the NTC thermistor rises. The LTC4160/LTC4160-1 are also designed to pause charging when the value of the NTC thermistor increases to 3.25 times the value of R25. For a Vishay Curve 1 100k thermistor, this resistance, 325k, corresponds to approximately 0°C. The hot and cold comparators each have approximately 3°C of hysteresis to prevent oscillation about the trip point. Grounding the NTC pin disables all NTC functionality.

Thermal Regulation

To prevent thermal damage to the LTC4160/LTC4160-1 or surrounding components, an internal thermal feedback loop will automatically decrease the programmed charge current if the die temperature rises to 105°C. This thermal regulation technique protects the LTC4160/LTC4160-1 from excessive temperature due to high power operation or high ambient thermal conditions, and allows the user to push the limits of the power handling capability with

a given circuit board design. The benefit of the LTC4160/LTC4160-1 thermal regulation loop is that charge current can be set according to actual conditions rather than worst-case conditions for a given application with the assurance that the charger will automatically reduce the current in worst-case conditions.

Overvoltage Protection

The LTC4160/LTC4160-1 can protect themselves from the inadvertent application of excessive voltage to V_{BUS} with just two external components: an N-channel MOSFET and a 6.2k resistor. The maximum safe overvoltage magnitude will be determined by the choice of the external MOSFET and its associated drain breakdown voltage.

The overvoltage protection circuit consists of two pins. The first, OVSENS, is used to measure the externally applied voltage through an external resistor. The second, OVGATE, is an output used to drive the gate pin of the external MOSFET. When OVSENS is below 6V, an internal charge pump will drive OVGATE to approximately 1.88 • OVSENS. This will enhance the N-channel MOSFET and provide a low impedance connection to V_{BUS} which will, in turn, power the LTC4160/LTC4160-1. If OVSENS should rise above 6V due to a fault or the use of an incorrect wall adapter, OVGATE will be pulled to GND. This disables the external MOSFET and protects downstream circuitry. When the voltage drops below 6V again, the external MOSFET will be re-enabled.

The charge pump output on OVGATE has limited output drive capability. Care must be taken to avoid leakage on this pin as it may adversely affect operation.

See the Applications Information section for resistor power dissipation rating calculations, a table of recommended components, and reverse-voltage protection.

Shutdown Mode

The USB switching regulator is enabled whenever V_{BUS} is above V_{UVLO} and the LTC4160/LTC4160-1 are not in USB suspend mode.

The ideal diode(s) are enabled at all times and cannot be disabled.

41601f

APPLICATIONS INFORMATION

Bidirectional PowerPath Switching Regulator CLPROG Resistor and Capacitor Selection

As described in the Bidirectional PowerPath Switching Regulator – Step-Down Mode section, the resistor on the CLPROG pin determines the average V_{BUS} input current limit. In step-down mode the switching regulator's V_{BUS} input current limit can be set to either the 1x mode (USB 100mA), the 5x mode (USB 500mA) or the 10x mode. The V_{BUS} input current will be comprised of two components, the current that is used to drive V_{OUT} and the quiescent current of the switching regulator. To ensure that the total average input current remains below the USB specification, both components of input current should be considered. The Electrical Characteristics table gives the typical values for quiescent currents in all settings as well as current limit programming accuracy. To get as close to the 500mA or 100mA specifications as possible, a precision resistor should be used. Recall that:

$$I_{VBUS} = I_{VBUSQ} + V_{CLPROG}/R_{CLPPROG} \cdot (h_{CLPROG} +1).$$

An averaging capacitor is required in parallel with the resistor so that the switching regulator can determine the average input current. This capacitor also provides the dominant pole for the feedback loop when current limit is reached. To ensure stability, the capacitor on CLPROG should be 0.1µF or larger.

Bidirectional PowerPath Switching Regulator Inductor Selection

Because the V_{BUS} voltage range and V_{OUT} voltage range of the PowerPath switching regulator are both fairly narrow, the LTC4160/LTC4160-1 were designed for a specific inductance value of 3.3µH. Some inductors which may be suitable for this application are listed in Table 3.

Table 3. Recommended PowerPath Inductors for the LTC4160/LTC4160-1

INDUCTOR TYPE	L (µH)	MAX IDC (A)	MAX DCR (Ω)	SIZE IN mm (L x W x H)	MANUFACTURER
LPS4018	3.3	2.2	0.08	3.9 x 3.9 x 1.7	Coilcraft www.coilcraft.com
D53LC DB318C	3.3 3.3	2.26 1.55	0.034 0.070	5 x 5 x 3 3.8 x 3.8 x 1.8	Toko www.toko.com
WE-TPC Type M1	3.3	1.95	0.065	4.8 x 4.8 x 1.8	Wurth Electronik www.we-online.com
CDRH6D12 CDRH6D38	3.3 3.3	2.2 3.5	0.063 0.020	6.7 x 6.7 x 1.5 7 x 7 x 4	Sumida www.sumida.com

Bidirectional PowerPath Switching Regulator V_{BUS} and V_{OUT} Bypass Capacitor Selection

The type and value of capacitors used with the LTC4160/LTC4160-1 determine several important parameters such as regulator control-loop stability and input voltage ripple. Because the LTC4160/LTC4160-1 use a bidirectional switching regulator between V_{BUS} and V_{OUT}, the V_{BUS} current waveform contains high frequency components. It is strongly recommended that a low equivalent series resistance (ESR) multilayer ceramic capacitor (MLCC) be used to bypass V_{BUS}. Tantalum and aluminum capacitors are not recommended because of their high ESR. The value of the capacitor on V_{BUS} directly controls the amount of input ripple for a given load current. Increasing the size of this capacitor will reduce the input ripple.

The inrush current limit specification for USB devices is calculated in terms of the total number of Coulombs needed to charge the V_{BUS} bypass capacitor to 5V. The maximum inrush charge for USB On-The-Go devices is 33µC. This places a limit of 6.5µF of capacitance on V_{BUS} assuming a linear capacitor. However, most ceramic capacitors have a capacitance that varies with bias voltage. The average capacitance needs to be less than 6.5µF over a 0V to 5V bias voltage range to meet the inrush current-limit specification. A 10µF capacitor in a 0805 package, such as the Murata GRM21BR71A106KE51L would be a suitable V_{BUS} bypass capacitor. If more capacitance is required for better noise performance and stability, it should be connected directly to the V_{BUS} pin when using the overvoltage protection circuit. This extra capacitance will be soft-connected over a couple of milliseconds to limit inrush current and avoid excessive transient voltage drops on V_{BUS}.

To prevent large V_{OUT} voltage steps during transient load conditions, it is also recommended that an MLCC be used to bypass V_{OUT}. The output capacitor is used in the compensation of the switching regulator. At least 10µF with low ESR are required on V_{OUT}. Additional capacitance will improve load transient performance and stability.

MLCCs typically have exceptional ESR performance. MLCCs combined with a tight board layout and an unbroken ground plane will yield very good performance and low EMI emissions.

41601f

21

APPLICATIONS INFORMATION

There are MLCCs available with several types of dielectrics each having considerably different characteristics. For example, X7R MLCCs have the best voltage and temperature stability. X5R MLCCs have apparently higher packing density but poorer performance over their rated voltage and temperature ranges. Y5V MLCCs have the highest packing density, but must be used with caution, because of their extreme nonlinear characteristic of capacitance versus voltage. The actual in-circuit capacitance of a ceramic capacitor should be measured with a small AC signal and DC bias as is expected in-circuit. Many vendors specify the capacitance versus voltage with a $1V_{RMS}$ AC test signal and, as a result, over state the capacitance that the capacitor will present in the application. Using similar operating conditions as the application, the user must measure or request from the vendor the actual capacitance to determine if the selected capacitor meets the minimum capacitance that the application requires.

Overvoltage Protection

V_{BUS} can be protected from overvoltage damage with two additional components, a resistor R1 and an N-channel MOSFET MN1, as shown in Figure 5. Suitable choices for MN1 are listed in Table 4.

Table 4. Recommended N-Channel MOSFETs for the Overvoltage Protection Circuit

PART #	BVDSS	R_{ON}	PACKAGE
Si1472DH	30V	57mΩ	SC70-6
Si2302ADS	20V	60mΩ	SOT-23
Si2306BDS	30V	47mΩ	SOT-23
Si2316DS	30V	50mΩ	SOT-23
IRLML2502	20V	50mΩ	SOT-23
FDN372S	30V	50mΩ	SOT-23
NTLJS4114N	30V	35mΩ	WDFN6
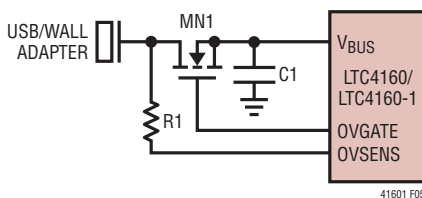
Figure 5. Overvoltage Protection

R1 is a 6.2k resistor and must be rated for the power dissipated during maximum overvoltage. In an overvoltage condition the OVSENS pin will be clamped at 6V. R1 must be sized appropriately to dissipate the resultant power. For example, a 1/10W 6.2k resistor can have at most $\sqrt{(PMAX \bullet 6.2k\Omega)} = 25V$ applied across its terminals. With the 6V at OVSENS, the maximum overvoltage magnitude that this resistor can withstand is 31V. A 1/4W 6.2k resistor raises this value to 45V. OVSENS's absolute maximum current rating of 10mA imposes an upper limit of 68V protection.

Reverse Voltage Protection

The LTC4160/LTC4160-1 can also be easily protected against the application of reverse voltages, as shown in Figure 6. D1 and R1 are necessary to limit the maximum V_{GS} seen by MP1 during positive overvoltage events. D1's breakdown voltage must be safely below MP1's BVGS. The circuit shown in Figure 6 offers forward voltage protection up to MN1's BVDSS and reverse voltage protection up to MP1's BVDSS.

V_{BUS} POSITIVE PROTECTION UP TO BVDSS OF MN1
V_{BUS} NEGATIVE PROTECTION UP TO BVDSS OF MP1
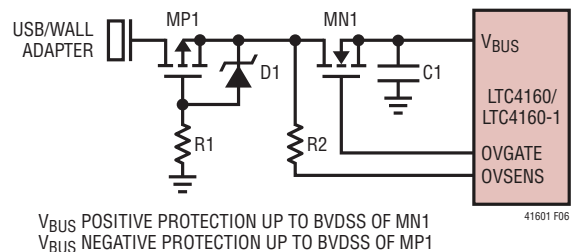
Figure 6. Dual Polarity Voltage Protection

Battery Charger Over Programming

The USB high power specification allows for up to 2.5W to be drawn from the USB port. The LTC4160/LTC4160-1's bidirectional switching regulator in step-down mode converts the voltage at V_{BUS} to a voltage just above BAT on V_{OUT}, while limiting power to less than the amount programmed at CLPROG. The charger should be programmed (with the PROG pin) to deliver the maximum safe charging current without regard to the USB specifications. If there is insufficient current available to charge the battery at the programmed rate, the charge current will be reduced until the system load on V_{OUT} is satisfied and the V_{BUS} current limit is satisfied. Programming the charger for more

41601f

APPLICATIONS INFORMATION

current than is available will not cause the average input current limit to be violated. It will merely allow the battery charger to make use of all available power to charge the battery as quickly as possible, and with minimal dissipation within the charger.

Battery Charger Stability Considerations

The LTC4160/LTC4160-1's battery charger contains both a constant-voltage and a constant-current control loop. The constant-voltage loop is stable without any compensation when a battery is connected with low impedance leads. Excessive lead length, however, may add enough series inductance to require a bypass capacitor of at least 1µF from BAT to GND.

High value, low ESR MLCCs reduce the constant-voltage loop phase margin, possibly resulting in instability. Up to 22µF may be used in parallel with a battery, but larger capacitors should be decoupled with 0.2Ω to 1Ω of series resistance.

Furthermore, a 100µF capacitor in series with a 0.3Ω resistor from BAT to GND is required to prevent oscillation when the battery is disconnected.

In constant-current mode, the PROG pin is in the feedback loop rather than the battery voltage. Because of the additional pole created by any PROG pin capacitance, capacitance on this pin must be kept to a minimum. With no additional capacitance on the PROG pin, the charger is stable with program resistor values as high as 25k. However, additional capacitance on this node reduces the maximum allowed program resistor. The pole frequency at the PROG pin should be kept above 100kHz. Therefore, if the PROG pin has a parasitic capacitance, C_{PROG}, the following equation should be used to calculate the maximum resistance value for R_{PROG}:

$$R_{PROG} \leq \frac{1}{2\pi \cdot 100kHz \cdot C_{PROG}}$$

Alternate NTC Thermistors and Biasing

The LTC4160/LTC4160-1 provide temperature qualified charging if a grounded thermistor and a bias resistor

are connected to NTC. By using a bias resistor whose value is equal to the room temperature resistance of the thermistor (R25) the upper and lower temperatures are pre-programmed to approximately 40°C and 0°C respectively assuming a Vishay Curve 1 thermistor.

The upper and lower temperature thresholds can be adjusted by either a modification of the bias resistor value or by adding a second adjustment resistor to the circuit. If only the bias resistor is adjusted, then either the upper or the lower threshold can be modified but not both. The other trip point will be determined by the characteristics of the thermistor. Using the bias resistor in addition to an adjustment resistor, both the upper and the lower temperature trip points can be independently programmed with the constraint that the difference between the upper and lower temperature thresholds cannot decrease. Examples of each technique are given below.

NTC thermistors have temperature characteristics which are indicated on resistance-temperature conversion tables. The Vishay-Dale thermistor NTHS0603N011-N1003F, used in the following examples, has a nominal value of 100k and follows the Vishay Curve 1 resistance-temperature characteristic.

In the explanation below, the following notation is used.

R25 = Value of the thermistor at 25°C

$R_{NTC|COLD}$ = Value of the thermistor at the cold trip point

$R_{NTC|HOT}$ = Value of the thermistor at the hot trip point

r_{COLD} = Ratio of $R_{NTC|COLD}$ to R25

r_{HOT} = Ratio of $R_{NTC|HOT}$ to R25

R_{NOM} – Primary thermistor bias resistor (see Figure 7)

R1 = Optional temperature range adjustment resistor (see Figure 8)

The trip points for the LTC4160/LTC4160-1's temperature qualification are internally programmed at 0.349•NTCBIAS for the hot threshold and 0.765 • NTCBIAS for the cold threshold.

41601f

23

APPLICATIONS INFORMATION

Therefore, the hot trip point is set when:

$$\frac{R_{NTC|HOT}}{R_{NOM} + R_{NTC|HOT}} \bullet NTCBIAS = 0.349 \bullet NTCBIAS$$

And the cold trip point is set when:

$$\frac{R_{NTC|COLD}}{R_{NOM} + R_{NTC|COLD}} \bullet NTCBIAS = 0.765 \bullet NTCBIAS$$

Solving these equations for $R_{NTC|COLD}$ and $R_{NTC|HOT}$ results in the following:

$$R_{NTC|HOT} = 0.536 \bullet R_{NOM}$$

and

$$R_{NTC|COLD} = 3.25 \bullet R_{NOM}$$

By setting R_{NOM} equal to R25, the above equations result in $r_{HOT} = 0.536$ and $r_{COLD} = 3.25$. Referencing these ratios to the Vishay Resistance-Temperature Curve 1 chart gives a hot trip point of about 40°C and a cold trip point of about 0°C. The difference between the hot and cold trip points is approximately 40°C.

By using a bias resistor, R_{NOM}, different in value from R25, the hot and cold trip points can be moved in either direction. The temperature span will change somewhat due to the non-linear behavior of the thermistor. The following equations can be used to calculate a new value for the bias resistor:

$$R_{NOM} = \frac{r_{HOT}}{0.536} \bullet R25$$

$$R_{NOM} = \frac{r_{COLD}}{3.25} \bullet R25$$

where r_{HOT} and r_{COLD} are the resistance ratios at the desired hot and cold trip points. Note that these equations are linked. Therefore, only one of the two trip points can be chosen, the other is determined by the default ratios designed in the IC. Consider an example where a 60°C hot trip point is desired.

From the Vishay Curve 1 R-T characteristics, r_{HOT} is 0.2488 at 60°C. Using the above equation, R_{NOM} should

be set to 46.4k. With this value of R_{NOM}, r_{COLD} is 1.436 and the cold trip point is about 16°C. Notice that the span is now 44°C rather than the previous 40°C. This is due to the decrease in "temperature gain" of the thermistor as absolute temperature increases.

The upper and lower temperature trip points can be independently programmed by using an additional bias resistor, R1, as shown in Figure 8. The following formulas can be used to compute the values of R_{NOM} and R1:

$$R_{NOM} = \frac{r_{COLD} - r_{HOT}}{2.714} \bullet R25$$
$$R1 = 0.536 \bullet R_{NOM} - r_{HOT} \bullet R25$$

For example, to set the trip points to 0°C and 45°C with a Vishay Curve 1 thermistor choose:

$$R_{NOM} = \frac{3.266 - 0.4368}{2.714} \bullet 100k = 104.2k$$

the nearest 1% value is 105k:

$$R1 = 0.536 \bullet 105k - 0.4368 \bullet 100k = 12.6k$$

the nearest 1% value is 12.7k. The final solution is shown in Figure 8 and results in an upper trip point of 45°C and a lower trip point of 0°C.

Figure 7. Standard NTC Configuration

41601f

APPLICATIONS INFORMATION

Figure 8. Modified NTC Configuration

Hot Plugging and USB Inrush Current Limiting

The overvoltage protection circuit provides inrush current limiting due to the long time it takes for OVGATE to fully enhance the N-channel MOSFET. This prevents the current from building up in the cable too quickly and dampens out any resonant overshoot on V_{BUS}. It is possible to observe voltage overshoot on V_{BUS} when connecting the LTC4160/LTC4160-1 to a lab supply if the overvoltage protection circuit is not used. This overshoot is caused by the inductance of the long leads from the supply to V_{BUS}. Twisting the wires together from the supply to V_{BUS} can greatly reduce the parasitic inductance of these long leads and keep V_{BUS} at a safe level. USB cables are generally manufactured with the power leads in close proximity and thus have fairly low parasitic inductance.

Hot Plugging and USB On-The-Go

If there is more than 4.3V on V_{BUS} when On-The-Go is enabled, the bidirectional switching regulator will not try to drive V_{BUS}. If USB On-The-Go is enabled and an external supply is then connected to V_{BUS}, one of three things will happen depending on the properties of the external supply. If the external supply has a regulation voltage higher than 5.1V, the bidirectional switching regulator will stop

switching and V_{BUS} will be held at the regulation voltage of the external supply. If the external supply has a lower regulation voltage and is capable of only sourcing current, then V_{BUS} will be regulated to 5.1V. The external supply will not source current to V_{BUS}.

For a supply that can also sink current and has a regulation voltage less than 5.1V, the bidirectional switching regulator will source current into the external supply in an attempt to bring V_{BUS} up to 5.1V. As long as the external supply holds V_{BUS} to more than V_{OUT} + 70mV, the bidirectional switching regulator will source up to 680mA into the supply. If V_{BUS} is held to a voltage that is less than V_{OUT} + 70mV then the short circuit timer will shut off the switching regulator after 7.2ms. The $\overline{FAULT}$ pin will then go low to indicate a short circuit current fault.

V_{BUS} Bypass Capacitance and USB On-The-Go Session Request Protocol

When two On-The-Go devices are connected, one will be the A device and the other will be the B device depending on whether the device is connected to a micro-A or micro-B plug. The A device provides power to the B device and starts as the host. To prolong battery life, the A device can power down V_{BUS} when the BUS is not being used. If the A device has powered down V_{BUS}, the B device can request the A device to power up V_{BUS} and start a new session using the session request protocol (SRP). The SRP consists of data-line pulsing and V_{BUS} pulsing. The B device must first pulse the D+ or D− data lines. The B device must then pulse V_{BUS} only if the A device does not respond to the data-line pulse. The A device is required to respond to only one of the pulsing methods. USB A devices that never power down V_{BUS} are not required to respond to the SRP.

For V_{BUS} pulsing, the limit on the V_{BUS} capacitance on the A device allows a B device to differentiate between a powered down On-The-Go device and a powered down standard host. The B device will send out a pulse of current that will raise V_{BUS} to a voltage between 2.1 and 5.25V if connected to an On-The-Go A device which must have no more than 6.5µF. An On-The-Go A device must drive V_{BUS} as soon as the current pulse raises V_{BUS} above 2.1V if the device is capable of responding to V_{BUS} pulsing.

41601f
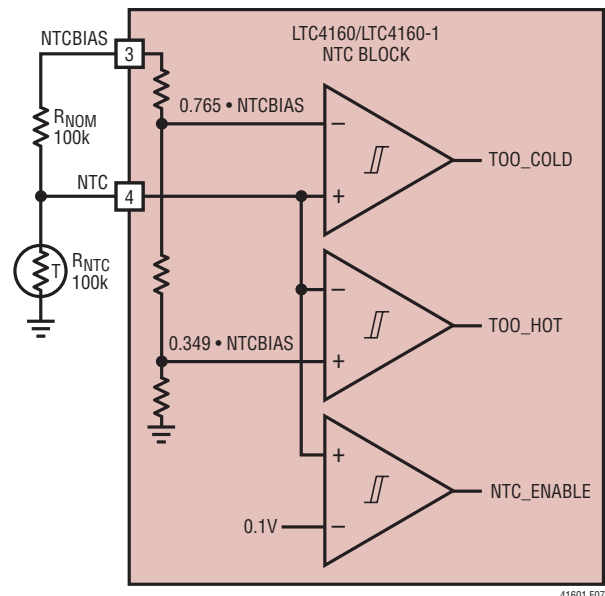
APPLICATIONS INFORMATION

This same current pulse must not raise V_{BUS} any higher than 2V when connected to a standard host which must have at least 96µF. The 96µF for a standard host represents the minimum capacitance with V_{BUS} between 4.75V and 5.25V. Since the SRP pulse must not drive V_{BUS} greater than 2V, the capacitance seen at these voltage levels can be greater than 96µF, especially if MLCCs are used. Therefore, the 96µF represents a lower bound on the standard host bypass capacitance for determining the amplitude and duration of the current pulse. More capacitance will only decrease the maximum level that V_{BUS} will rise to for a given current pulse.

Figure 9 shows an On-The-Go device using the LTC4160/LTC4160-1 acting as the A device. Additional capacitance can be placed on the V_{BUS} pin of the LTC4160/LTC4160-1 when using the overvoltage protection circuit. The B device may not be able to distinguish between a powered down LTC4160/LTC4160-1 with overvoltage protection and a powered down standard host because of this extra capacitance. In addition, if the SRP pulse raises V_{BUS} above its UVLO threshold of 4.3V the LTC4160/LTC4160-1 will assume input power is available and will not attempt to drive V_{BUS}. Therefore, it is recommended that an On-The-Go device using the LTC4160/LTC4160-1 respond to data-line pulsing.

When an On-The-Go device using the LTC4160/LTC4160-1 becomes the B device, as in Figure 10, it must send out a data line pulse followed by a V_{BUS} pulse to request a session from the A device. The On-The-Go device designer can choose how much capacitance will be placed on the V_{BUS} pin of the LTC4160/LTC4160-1 and then generate a V_{BUS} pulse that can distinguish between a powered down On-The-Go A device and a powered down standard host. A suitable pulse can be generated because of the disparity in the bypass capacitances of an On-The-Go A device and a standard host even if there is somewhat more than 6.5µF capacitance connected to the V_{BUS} pin of the LTC4160/LTC4160-1.

Board Layout Considerations

The Exposed Pad on the backside of the LTC4160/LTC4160-1 package must be securely soldered to the PC board ground. This is the primary ground pin in the package, and it serves as the return path for both the control circuitry and N-channel MOSFET switch.

Furthermore, due to its high frequency switching circuitry, it is imperative that the input capacitor, inductor, and output capacitor be as close to the LTC4160/LTC4160-1 as possible and that there be an unbroken ground plane under the LTC4160/LTC4160-1 and all of its external high frequency components. High frequency current, such as the V_{BUS} current tends to find its way on the ground plane along a mirror path directly beneath the incident path on the top of the board. If there are slits or cuts in the ground plane due to other traces on that layer, the current will be forced to go around the slits. If high frequency currents are not allowed to flow back through their natural least-area path, excessive voltage will build up and radiated emissions will occur (see Figure 11). There should be a group of vias directly under the grounded backside leading directly down to an internal ground plane. To minimize parasitic inductance, the ground plane should be as close as possible to the top plane of the PC board (layer 2).
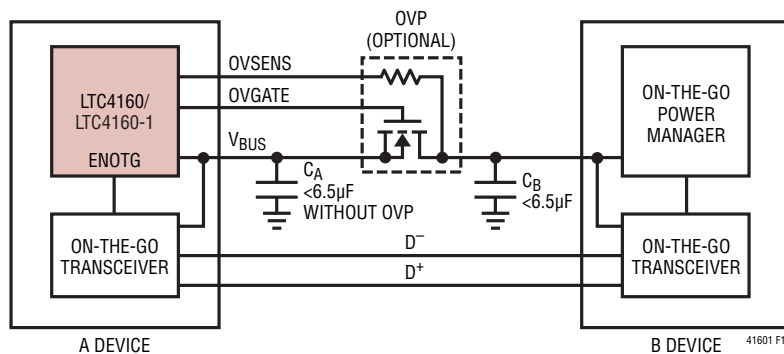
Figure 9. LTC4160/LTC4160-1 as the A Device

41601f

APPLICATIONS INFORMATION
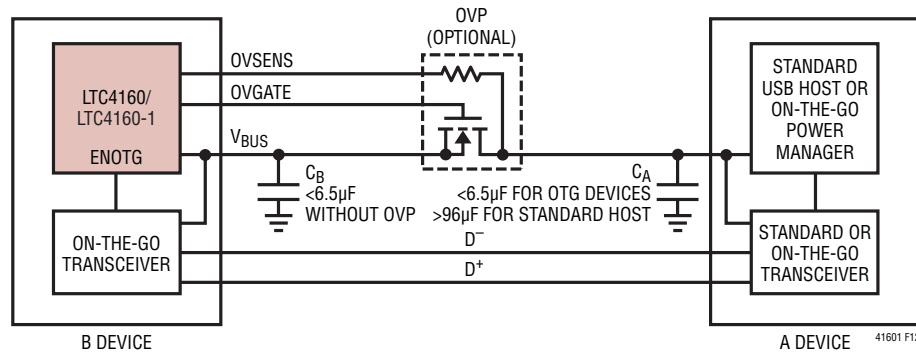
Figure 10. LTC4160/LTC4160-1 as the B Device
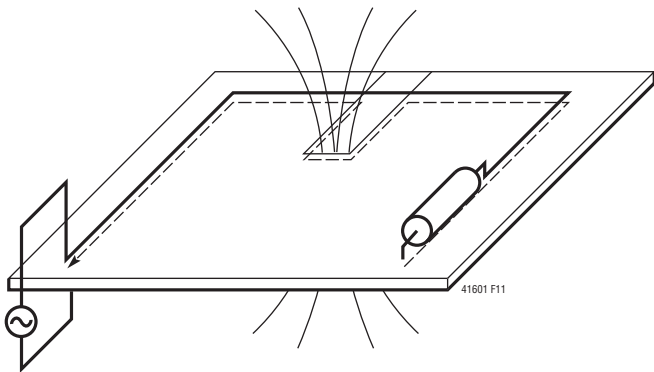
Figure 11. Higher Frequency Ground Current Follow Their Incident Path. Slices in the Ground Plane Create Large Loop Areas. The Large Loop Areas Increase the Inductance of the Path Leading to Higher System Noise.

The IDGATE pin for the external ideal diode controller has extremely limited drive current. Care must be taken to minimize leakage to adjacent PC board traces. 100nA of leakage from this pin will introduce an additional offset to the ideal diode of approximately 10mV. To minimize leakage, the trace can be guarded on the PC board by surrounding it with V_{OUT} connected metal, which should generally be less than one volt higher than IDGATE.

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the LTC4160/LTC4160-1:

1. The Exposed Pad of the package (Pin 21) should connect directly to a large ground plane to minimize thermal and electrical impedance.

2. The trace connecting V_{BUS} to its respective decoupling capacitor should be as short as possible. The GND side of these capacitors should connect directly to the ground plane of the part. These capacitors provide the AC current to the internal power MOSFETs and their drivers. It is critical to minimize inductance from these capacitors to the LTC4160/LTC4160-1.

3. Connections between the PowerPath switching regulator inductor and the output capacitor on V_{OUT} should be kept as short as possible. Use area fills whenever possible. The GND side of the output capacitors should connect directly to the thermal ground plane of the part.

4. The switching power trace connecting SW to its respective inductor should be minimized to reduce radiated EMI and parasitic coupling.

LTC4160/LTC4160-1

TYPICAL APPLICATIONS

Low Component Count Power Manager/Battery Charger with USB On-The-Go and Low Battery Start-Up

C1: MURATA GRM21BR7A106KE51L
C3: TAYIO YUDEN JMK212BJ226MG
L1: COILCRAFT LPS4018-332LM

41601 TA02
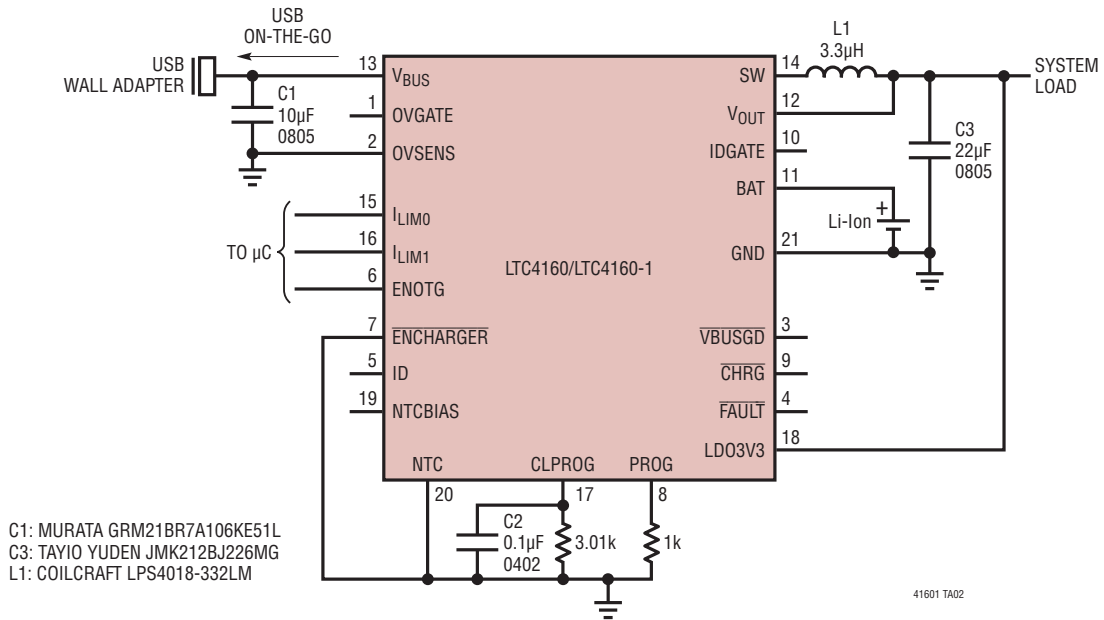
Low Component Count Switching Battery Charger with USB On-The-Go

C1: MURATA GRM21BR7A106KE51L
C3: TAYIO YUDEN JMK212BJ226MG
L1: COILCRAFT LPS4018-332LM

41601 TA03
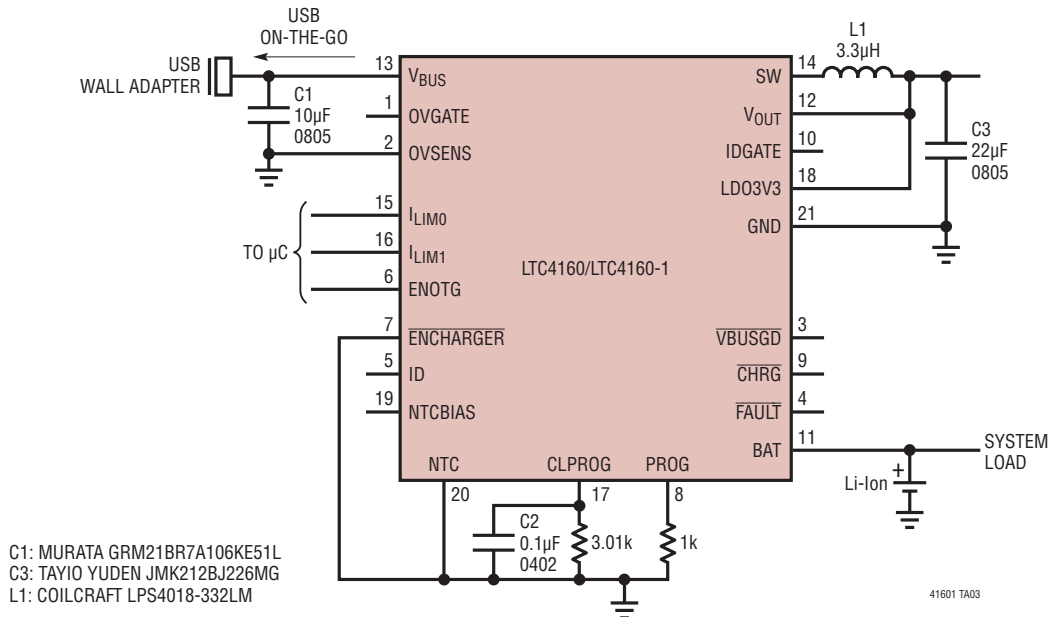
41601f

TYPICAL APPLICATIONS

High Efficiency Power Manager/Battery Charger with USB On-The-Go, Overvoltage Protection and Low Battery Start-Up

C1, C3: TAYIO YUDEN JMK212BJ226MG
L1: COILCRAFT LPS4018-332LM
M1: FAIRCHILD FDN372S
M2: SILICONIX Si2333DS
R1: 1/10 WATT RESISTOR
R2: VISHAY CURVE 1

41601 TA04

TYPICAL APPLICATIONS

High Efficiency Switching Battery Charger with USB On-The-Go, Overvoltage and Reverse-Voltage Protection

C1, C3: TAYIO YUDEN JMK212BJ226MG
L1: COILCRAFT LPS4018-332LM
M1: SILICONIX Si2333DS
M2: FAIRCHILD FDN372S
R1: 1/10 WATT RESISTOR
R2: VISHAY CURVE 1
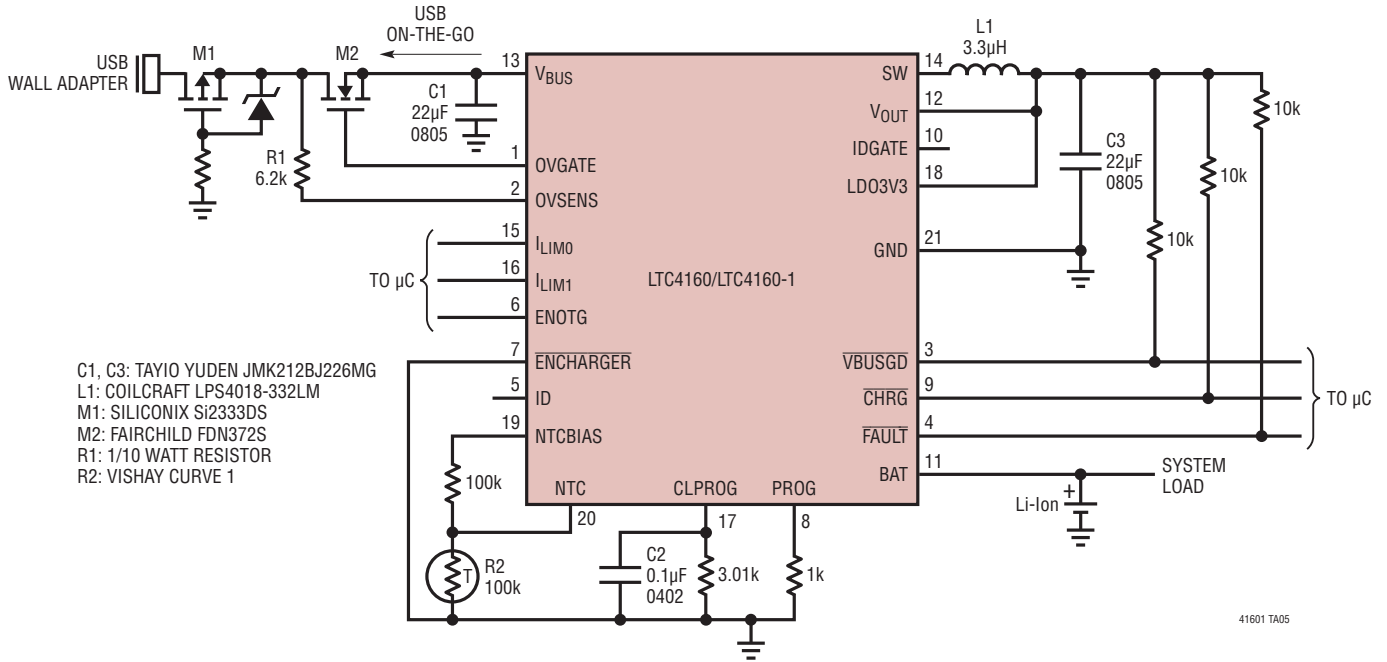
41601 TA05

41601f

PACKAGE DESCRIPTION

PDC Package
20-Lead Plastic UTQFN (3mm × 4mm)
(Reference LTC DWG # 05-08-1752 Rev Ø)
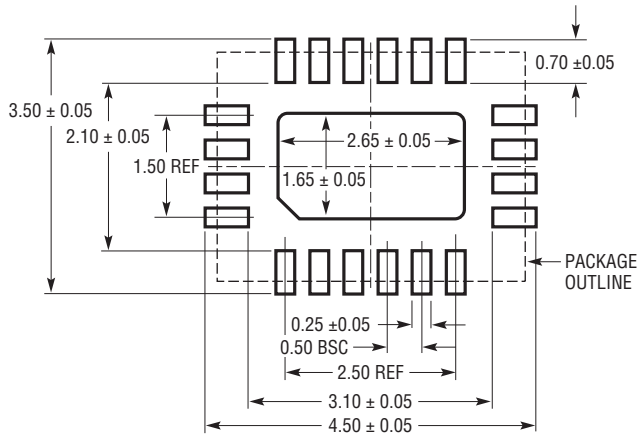
RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS
APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED

BOTTOM VIEW—EXPOSED PAD
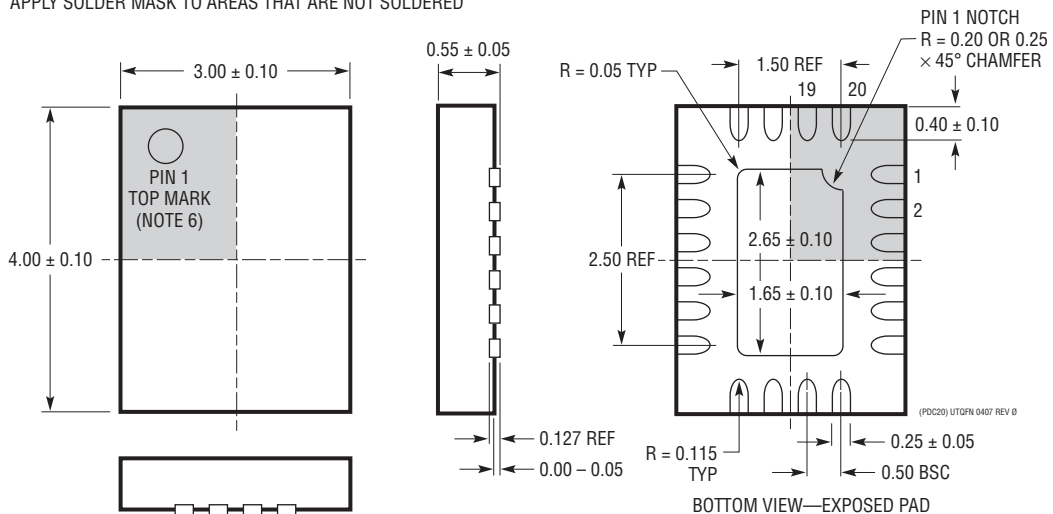
NOTE:
1. DRAWING IS NOT A JEDEC PACKAGE OUTLINE
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE
   MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION
   ON THE TOP AND BOTTOM OF PACKAGE

Information furnished by Linear Technology Corporation is believed to be accurate and reliable. However, no responsibility is assumed for its use. Linear Technology Corporation makes no representation that the interconnection of its circuits as described herein will not infringe on existing patent rights.

41601f

31

TYPICAL APPLICATION

Power Manager/Battery Charger with Automatic USB On-The-Go and Overvoltage Protection

C1, C3: TAYIO YUDEN JMK212BJ226MG
J1: HIROSE ZX62-AB-5PA
L1: COILCRAFT LPS4018-332LM
M1: FAIRCHILD FDN372S
M2: SILICONIX Si2333DS
R1: 1/10 WATT RESISTOR

V$_{BUS}$ POWERS UP WHEN ID PIN HAS LESS THAN 10Ω TO GND (MICRO-A PLUG CONNECTED)

41601 TA06

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
Power Management		
LTC3556	Switching USB Power Manager with Li-Ion/Polymer Charger Plus Dual Buck Plus Buck-Boost DC/DC	Maximizes Available Power from USB Port, Bat-Track, Instant-On Operation, 1.5A Max Charge Current, 180mΩ Ideal Diode with <50mΩ Option, 3.3V/25mA Always-On LDO, Two 400mA Buck Regulators, One 1A Buck-Boost Regulator, 4mm × 5mm 28-Pin QFN Package
LTC3576/ LTC3576-1	Switching USB Power Manager with USB On-The-Go Plus Triple Buck DC/DC	Maximizes Available Power from USB Port, Bat-Track, 5V Boost for USB On-The-Go, Instant-On Operation, 1.5A Max Charge Current, 180mΩ Ideal Diode with <50mΩ Option, Controller for External High Voltage Buck Regulator, Protection Against Transients of Up to 68V, 3.3V/20mA Always-On LDO, Two 400mA and One 1A Buck Regulators, 4.1V Float Voltage (LTC3576-1) 4mm × 6mm 38-Pin QFN Package
LTC3586/ LTC3586-1	Switching USB Power Manager with Li-Ion/Polymer Charger Plus Dual Buck Plus Buck-Boost Plus Boost DC/DC	Maximizes Available Power from USB Port, Bat-Track, Instant-On Operation, 1.5A Max Charge Current, 180mΩ Ideal Diode with <50mΩ Option, 3.3V/25mA Always-On LDO, Two 400mA Synchronous Buck Regulators, One 1A Buck-Boost Regulator, One 600mA Boost regulator, 4.1V Float Voltage (LTC3586-1) 4mm × 6mm 38-Pin QFN Package
LTC4098/ LTC4098-1	Switching USB Power Manager and Battery Charger With Overvoltage Protection	Maximizes Available Power from USB Port, Bat-Track, Instant-On Operation, 1.5A Max Charge Current, 180mΩ Ideal Diode with <50mΩ Option, Controller for External High Voltage Buck Regulator, Protection Against Transients Up to 68V, 4.1V Float Voltage (LTC4098-1) 4mm × 3mm 20-Pin UTQFN Package
LTC4099	I^{2}C Controlled USB Power Manager and Battery Charger With Overvoltage Protection	Maximizes Available Power from USB Port, Bat-Track, Instant-On Operation, 1.5A Max Charge Current, 180mΩ Ideal Diode with <50mΩ Option, Controller for External High Voltage Buck Regulator, Protection Against Transients of Up to 68V, I^{2}C Control of Input/Charge Current and Float Voltage with Status Read Back, 4mm × 3mm 20-Pin UTQFN Package

Linear Technology Corporation
1630 McCarthy Blvd., Milpitas, CA 95035-7417
(408) 432-1900 • FAX: (408) 434-0507 • www.linear.com

LT 0409 • PRINTED IN USA

© LINEAR TECHNOLOGY CORPORATION 2009

41601f